

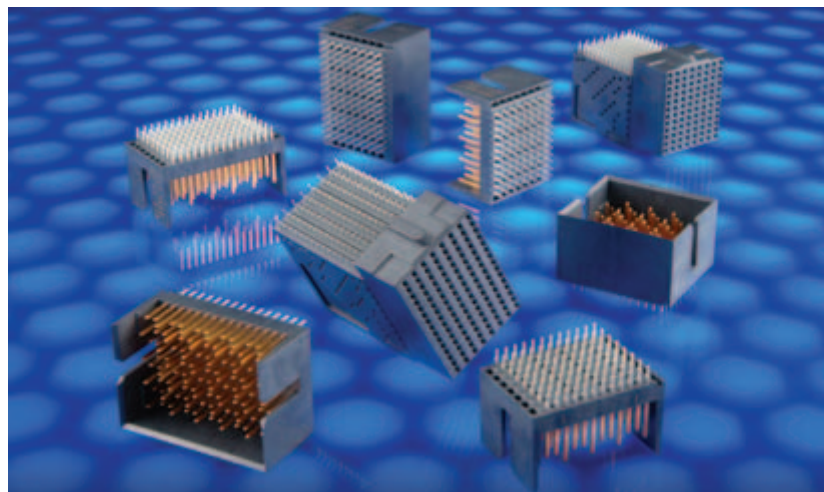
Introduction

Product Facts

- 10+ Gbps performance
- 100 ohm Impedance for Differential Pair configuration
- 5 pair version offers 26 pairs/10mm [66 differential pairs/inch] fitting within a 25.40 [1.00] card slot pitch
- 4 pair version offers 21 pairs/10mm [53 differential pairs/inch] fitting within a 20.30 [.800] card slot pitch
- 3 pair version offering 16 pairs/10mm [40 differential pairs/inch] fitting within a 16.25 [.625] card slot pitch
- Right angle pin headers (coplanar) in 3 pair, 4 pair, and 5 pair versions
- Reliable, redundant contact design on every signal contact
- Modular system offered in various column versions
- Meets Industry reliability requirements of Bellcore/Telcordia
- Sequencing for ground and signal contacts
- RoHS Compliant

Future Product Extensions

- Vertical receptacles (mezzanine)
- High speed cable assemblies and hardware



The Z-PACK MAX Backplane Connector family is a cost-effective solution for customers searching for a high density, high performance backplane interconnect system.

The Z-PACK MAX Connector design follows proven industry backplane convention by offering a fully protected right-angle receptacle for use on daughtercards where handling damage can be a concern when mating to a vertical male header. This connector permits field repairability at either the module or single pin levels.

Ground contacts positioned within each column of the connector, combined with unique contact lead frame arrangements, enable the Z-PACK MAX Connector to achieve low crosstalk and high through-put performance levels. Reliability is provided with a dual point of contact mating interface and compliant pin interface to the printed circuit board.

Industry Applications

Ideally designed for cost pressured, high signal density applications requiring interconnection between two printed circuit boards, such as those typically found in server, storage, switch, router, and similar applications. The Z-PACK MAX Connector product family is suited to meet the demands of today's modular system designs by offering a variety of configurations. The product family includes configurations to fit 20.32 [.800] and 25.40 [1.00] card slot spacing.

Technical Documents

- Product Specification** 108-2205
- Application Specification** 114-13144
- Routing Guide Report** #25GC004-1

Material and Finish

- Signal Contact** — High Strength Copper Alloy
- Ground Contact** — High Strength Copper Alloy
- Housing** — Liquid Crystal Polymer
- Platings** — Telcordia compliant interface, Nickel underplate
- Compliant Pin Plating** — RoHS Compliant

Ratings

- Temperature Range** — -65°C to +90°C
- Current Rating** — 0.5 A/contact @ < 30°C T-Rise
- Durability** — 200 cycles
- Dielectric Withstanding Voltage** — 560 VAC
- Operating Voltage** — 250 VAC max.

Signal Integrity

- Characteristic Impedance** — Differential @ 100 ohms ±10%
- Crosstalk** — Multi-pair differential crosstalk: 2.1% @ 50ps
- Insertion Loss** — -2 dB @ 10 GHz

For additional information visit:
<http://www.tycoelectronics.com/zpackmax>

Introduction (Continued)**Need more information?**

Call Technical Support at the numbers listed below.

Technical Support is staffed with specialists well versed in Tyco Electronics products. They can provide you with:

- Technical support
- Catalogs
- Technical Documents
- Product Samples
- Authorized Distributor Locations

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At Tyco Electronics, we're ready to support your RoHS requirements. We've assessed more than 1.5 million end items/components for RoHS compliance, and issued new part numbers where any change was required to eliminate the restricted materials. Part numbers in this catalog are identified as:

RoHS Compliant — Part numbers in this catalog are RoHS Compliant, unless marked otherwise. These products comply with European Union Directive 2002/95/EC as amended 1 January 2006 that restricts the use of lead, mercury, cadmium, hexavalent chromium, PBB, and PBDE in certain electrical and electronic products sold into the EU as of 1 July 2006.

NOTE: For purposes of this Catalog, included within the definition of RoHS Compliant are products that are clearly "Out of Scope" of the RoHS Directive such as hand tools and other non-electrical accessories.

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Our comprehensive on-line RoHS Customer Support Center provides a forum to answer your questions and support your RoHS needs. A RoHS FAQ (Frequently Asked Questions) is available with links to more detailed information. You can also submit RoHS questions and receive a response within 24 hours during a normal work week. The Support Center also provides:

- Cross-Reference from Non-compliant to Compliant Products
- Ability to browse RoHS Compliant Products in our on-line catalog
- Downloadable Technical Data Customer Information Presentation
- More detailed information regarding the definitions used above
- So whatever your questions when it comes to RoHS, we've got the answers at www.tycoelectronics.com/leadfree

RoHS
Customer
Support
Center 

Table of Contents**Introduction** (Continued)

Introduction	1-5
Table of Contents	3
5 Pair Right Angle Receptacle Assemblies	6
4 Pair Right Angle Receptacle Assemblies	7
3 Pair Right Angle Receptacle Assemblies	8
5 Pair Vertical Header Assemblies	9
5 Pair Vertical Header Assemblies — Single End Wall	10
5 Pair Vertical Header Assemblies — Double End Walls	11
4 Pair Vertical Header Assemblies	12
4 Pair Vertical Header Assemblies — Single End Wall	13
4 Pair Vertical Header Assemblies — Double End Walls	14
3 Pair Vertical Header Assemblies	15
3 Pair Vertical Header Assemblies — Single End Wall	16
3 Pair Vertical Header Assemblies — Double End Walls	17
5 Pair Right Angle Pin Header Assemblies	18
5 Pair Right Angle Pin Header Assemblies — Double End Walls	19
4 Pair Right Angle Pin Header Assemblies	20
4 Pair Right Angle Pin Header Assemblies — Double End Walls	21
3 Pair Right Angle Pin Header Assemblies	22
3 Pair Right Angle Pin Header Assemblies — Double End Walls	23
Z-PACK MAX Mid-Plane (Orthogonal) Connector Overview	24-26
6 Pair Mid-Plane Assemblies	27-29
4 Pair Mid-Plane Assemblies	30-32
Z-PACK MAX Product Mating Sequence Chart	33
Part Number Index	34

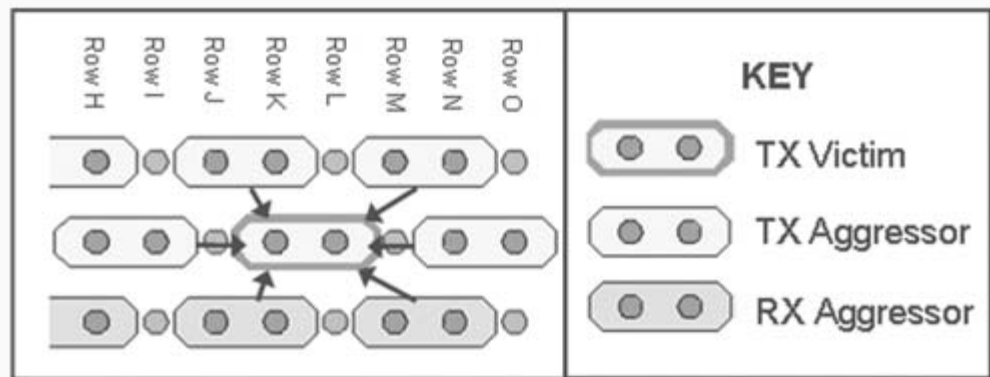
Introduction (Continued)

Noise Table

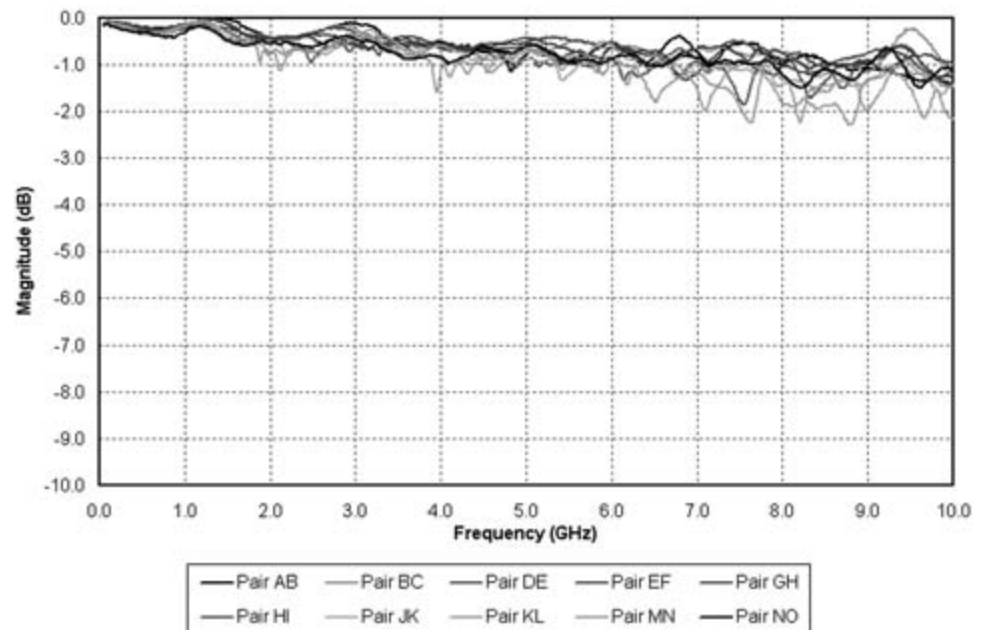
- Maximum, multiple source crosstalk

Victim Pair	Total Peak Receiver Noise for Recommended Pin-Out
AB9	0.8%
BC8	1.6%
DE9	1.9%
EF8	1.9%
GH9	2.0%
HI8	2.0%
JG9	2.0%
KL8	2.1%
MN9	1.7%
NO8	0.8%

Note: Data includes PCB vias of both backplane and daughtercard connectors. Single mated connector pair 50 ps (20-80%) edge rate



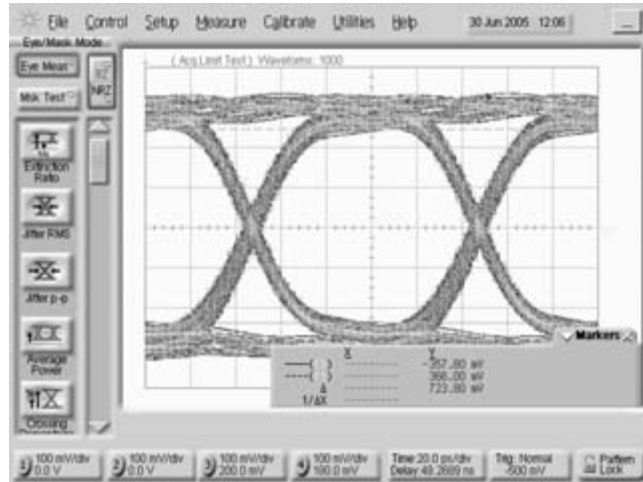
Insertion Loss Plot



Introduction (Continued)

Representative Eye Pattern

- 10.0 Gbps data rate
- 2⁷-1 PRBS
- Unequalized Signal



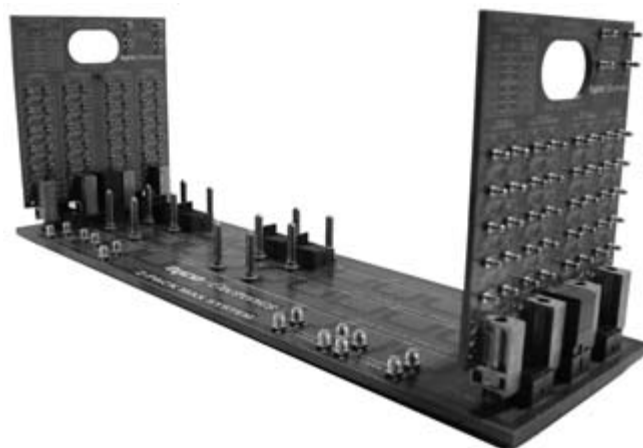
Customer Connector Evaluation Kit

- Connector characterization
- Available for loan — contact your local Tyco Electronics Sales Engineer
- Time and frequency domain testable
- Testable to 18+ GHz (25+ Gb/s)
- Multiple calibration options
- Convenient SMA interface



Customer System Evaluation Kit

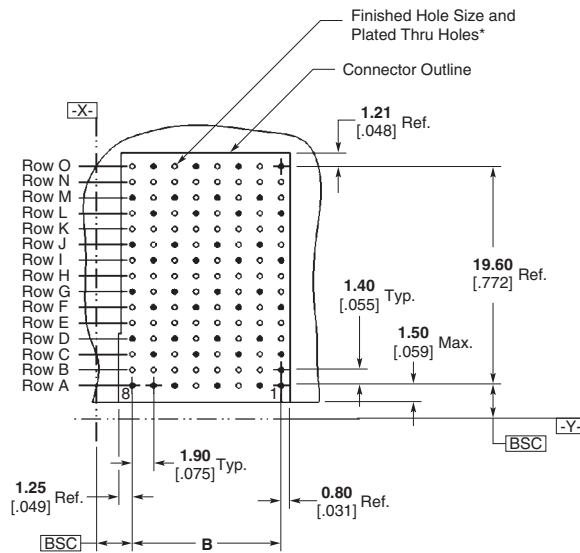
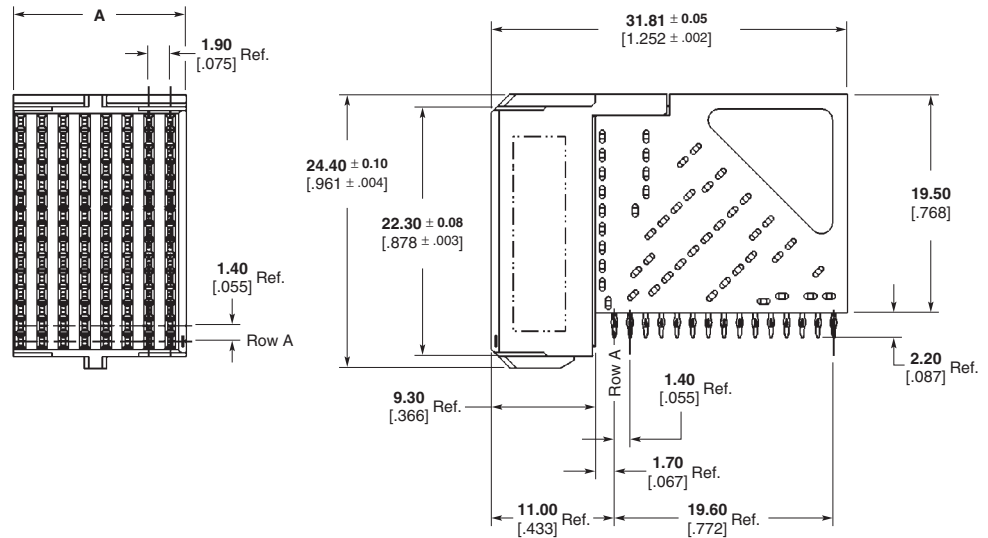
- System characterization
- Available for loan — contact your local Tyco Electronics Sales Engineer
- Time and frequency domain testable
- Testable to 18+ GHz (25+ Gb/s)
- Multiple system lengths
- Convenient SMA interface



5 Pair Right Angle Receptacle Assemblies

Column	Part Number	Dimension		Application Tooling	Mates With
		A	B		
8	1469659-1	15.35 .604	13.30 .524	*	1469660-1, 1469680-1, 1469681-1, 1469735-1, 1469737-1
16	1469754-1	30.55 1.203	28.50 1.122	*	1469753-1, 1469755-1, 1469756-1, 1934018-1, 1934021-1

* Custom tooling not required. Utilizes flat-rock insertion tooling. Reference Application Specification 114-13144.



Note: For additional information on pcb routing guidelines, reference the Z-PACK MAX Connector Routing Guide Report #25GC004-1.

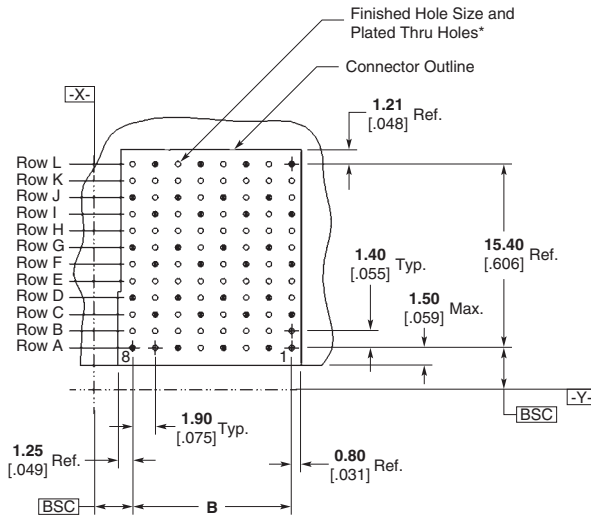
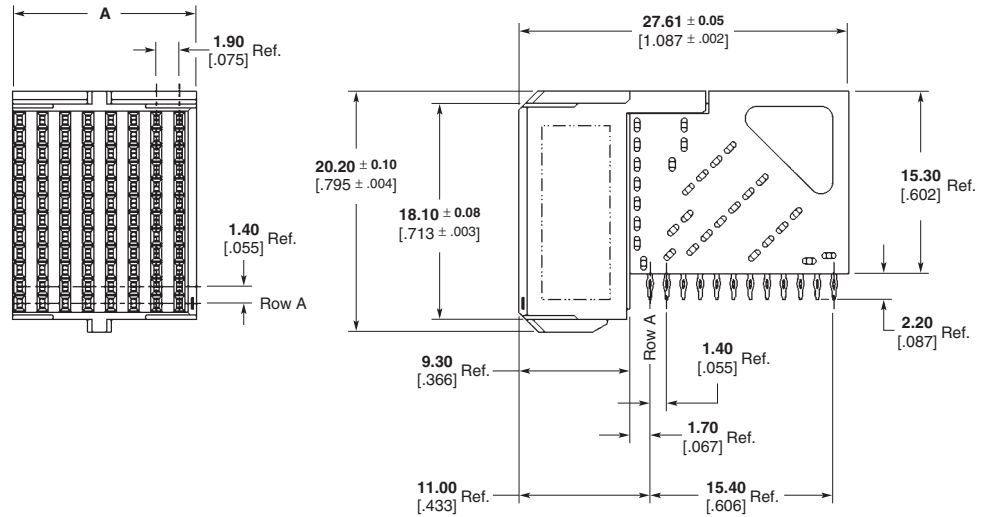
**Recommended PC Board Layout
Daughterboard
Component Side Shown**

* Finished Hole Diameter = 0.46 ± 0.05 [.018 ± .002]
 Drilled Hole Diameter = 0.55 ± 0.02 [.022 ± .001]
 Copper Thickness = 0.038 ± 0.013 [.0015 ± .0005]
 Tin-Lead Thickness = 0.008 ± 0.004 [.0003 ± .0002]
 Finishes other than Tin-Lead, See Appl. Spec. 114-13144

4 Pair Right Angle Receptacle Assemblies

Column	Part Number	Dimension		Application Tooling	Mates With
		A	B		
8	1469717-1	15.35 .604	13.30 .524	*	1469716-1, 1469702-1, 1469706-1, 1469793-1, 1469795-1
16	1469693-1	30.55 1.203	28.50 1.122	*	1469687-1, 1469703-1, 1469707-1, 1934026-1, 1934029-1

* Custom tooling not required. Utilizes flat-rock insertion tooling. Reference Application Specification 114-13144.



Note: For additional information on pcb routing guidelines, reference the Z-PACK MAX Connector Routing Guide Report #25GC004-1.

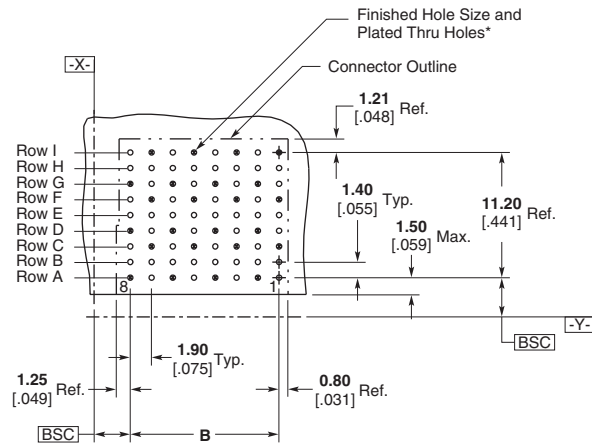
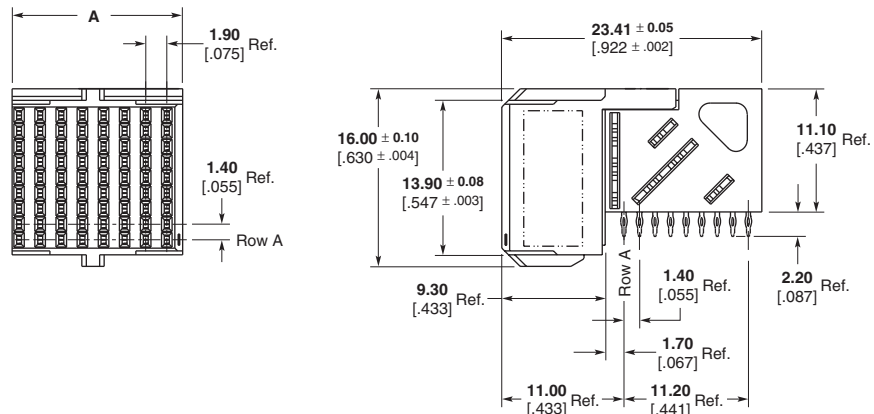
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Daughterboard
Component Side Shown**

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 Tin-Lead Thickness = 0.008 ± 0.004 [0.0003 ± .0002]
 Finishes other than Tin-Lead, See Appl. Spec. 114-13144

3 Pair Right Angle Receptacle Assemblies

Column	Part Number	Dimension		Application Tooling	Mates With
		A	B		
8	1469831-1	15.35 .604	13.30 .524	*	1469829-1, 1469945-1, 1469946-1, 1469974-1, 1469977-1
10	1469828-1	19.15 .754	17.10 .673	*	1469827-1, 1469867-1, 1469935-1, 1469871-1, 1469874-1
16	1469955-1	30.55 1.203	28.50 1.122	*	1469949-1, 1469950-1, 1469951-1, 1934034-1, 1934037-1

* Custom tooling not required. Utilizes flat-rock insertion tooling. Reference Application Specification 114-13144.



**Recommended PC Board Layout
Component Side Shown**

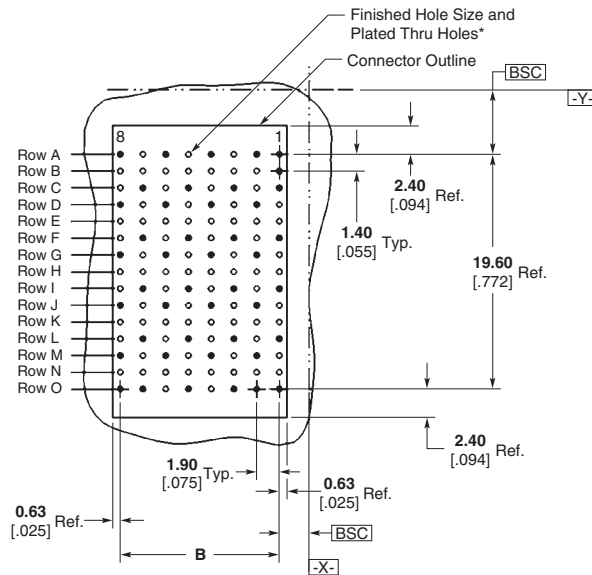
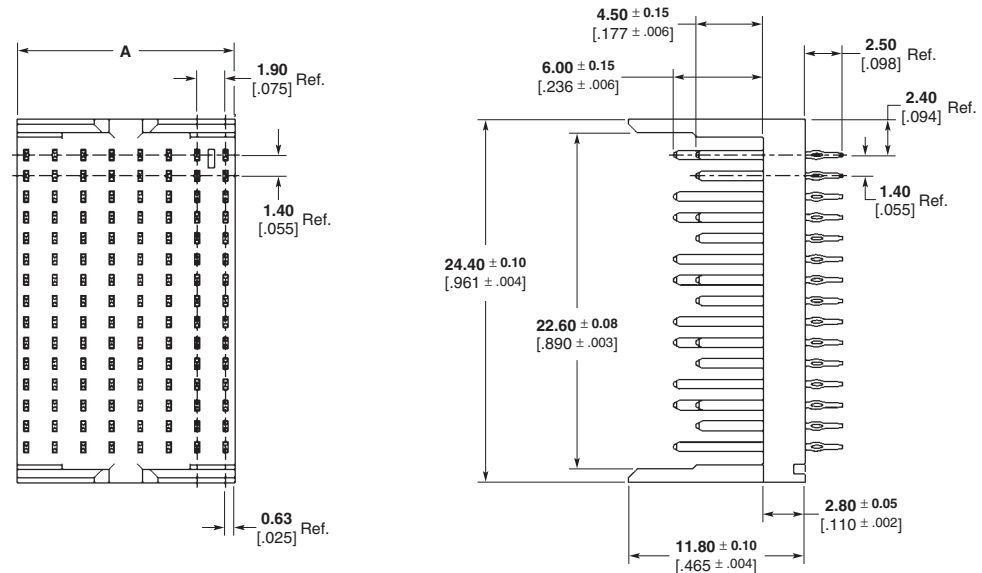
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 Finishes other than Tin-Lead, See Appl. Spec. 114-13144

5 Pair Vertical Header Assemblies

Column	Part Number	Dimension		Application Tooling*	Mates With
		A	B		
8	1469660-1	14.55 .573	13.30 .524	1804791-1	1469659-1
16	1469753-1	29.75 1.171	28.50 1.122	1804791-3	1469754-1

* Reference Application Specification 114-13144.



Note: For additional information on pcb routing guidelines, reference the Z-PACK MAX Connector Routing Guide Report #25GC004-1.

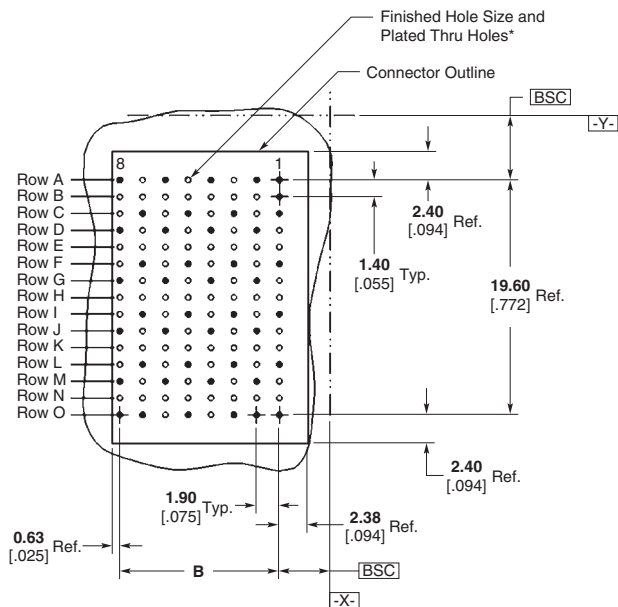
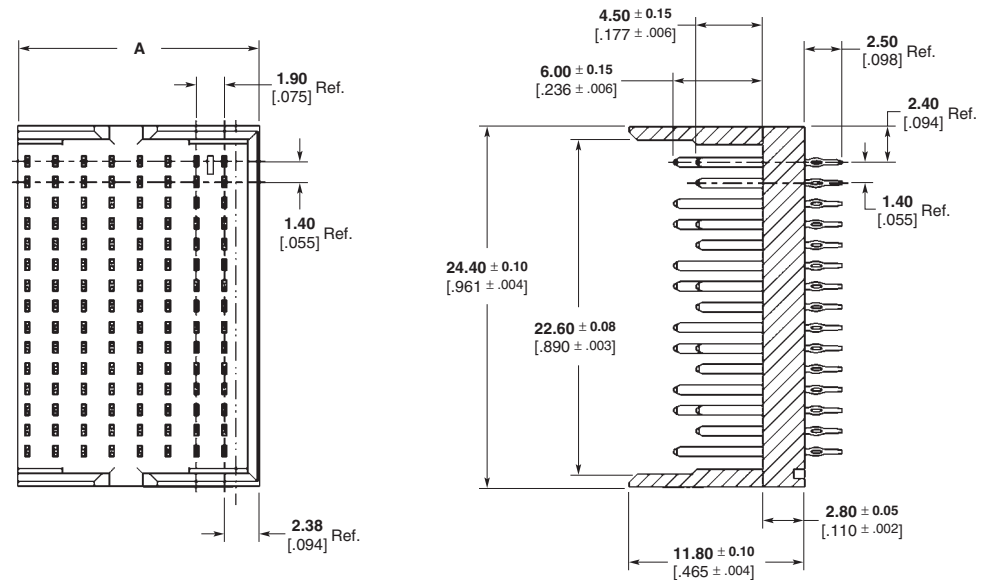
**Recommended PC Board Layout
Backplane
Component Side Shown**

* Finished Hole Diameter = 0.46 ± 0.05 [.018 ± .002]
 Drilled Hole Diameter = 0.55 ± 0.02 [.022 ± .001]
 Copper Thickness = 0.038 ± 0.013 [.0015 ± .0005]
 Tin-Lead Thickness = 0.008 ± 0.004 [.0003 ± .0002]
 Finishes other than Tin-Lead, See Appl. Spec. 114-13144

5 Pair Vertical Header Assemblies — Single End Wall

Column	Part Number	Dimension		Application Tooling*	Mates With
		A	B		
8	1469680-1	16.30 .642	13.30 .524	1804791-1	1469659-1
16	1469755-1	31.50 1.240	28.50 1.122	1804791-3	1469754-1

* Reference Application Specification 114-13144.



Note: For additional information on pcb routing guidelines, reference the Z-PACK MAX Connector Routing Guide Report #25GC004-1.

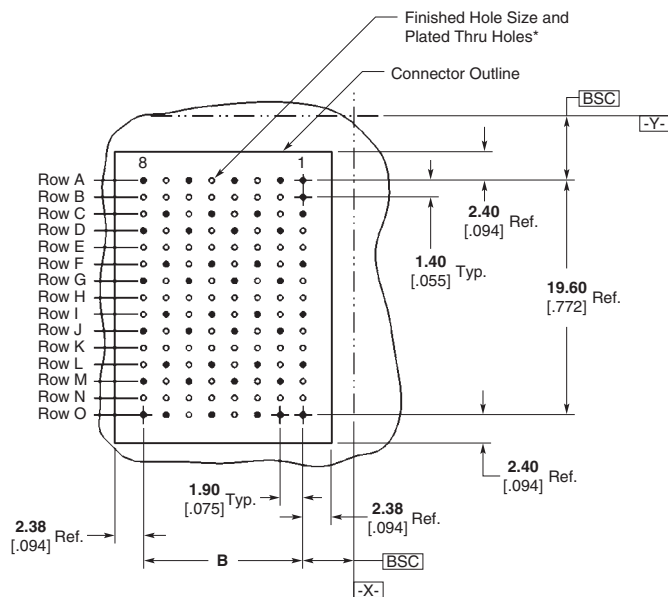
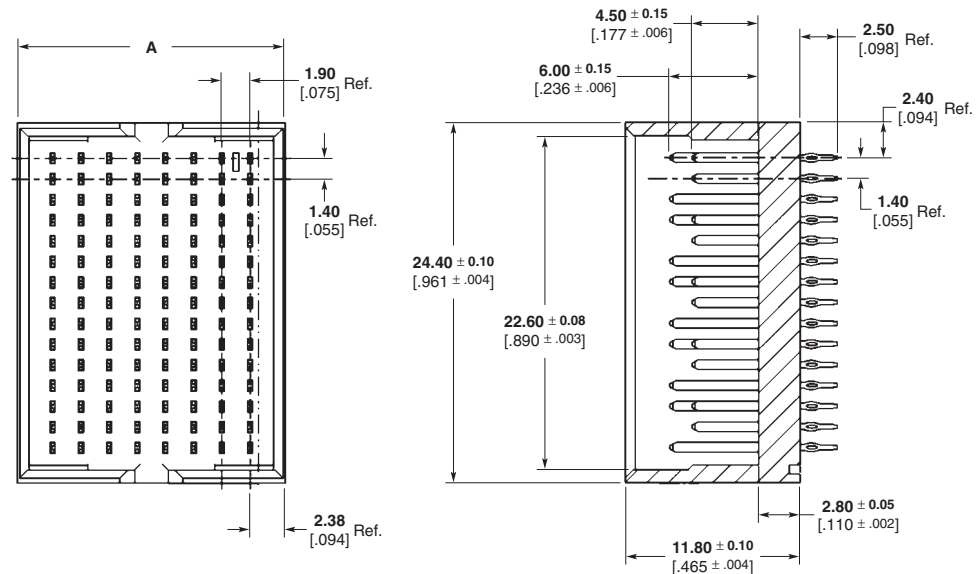
Recommended PC Board Layout Backplane Component Side Shown

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 Finishes other than Tin-Lead, See Appl. Spec. 114-13144

5 Pair Vertical Header Assemblies — Double End Walls

Column	Part Number	Dimension		Application Tooling*	Mates With
		A	B		
8	1469681-1	18.05 .711	13.30 .524	1804791-1	1469659-1
16	1469756-1	33.25 1.309	28.50 1.122	1804791-3	1469754-1

* Reference Application Specification 114-13144.



Note: For additional information on pcb routing guidelines, reference the Z-PACK MAX Connector Routing Guide Report #25GC004-1.

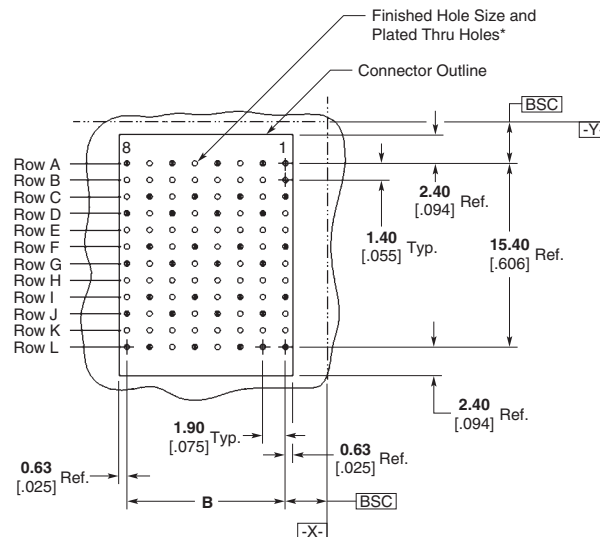
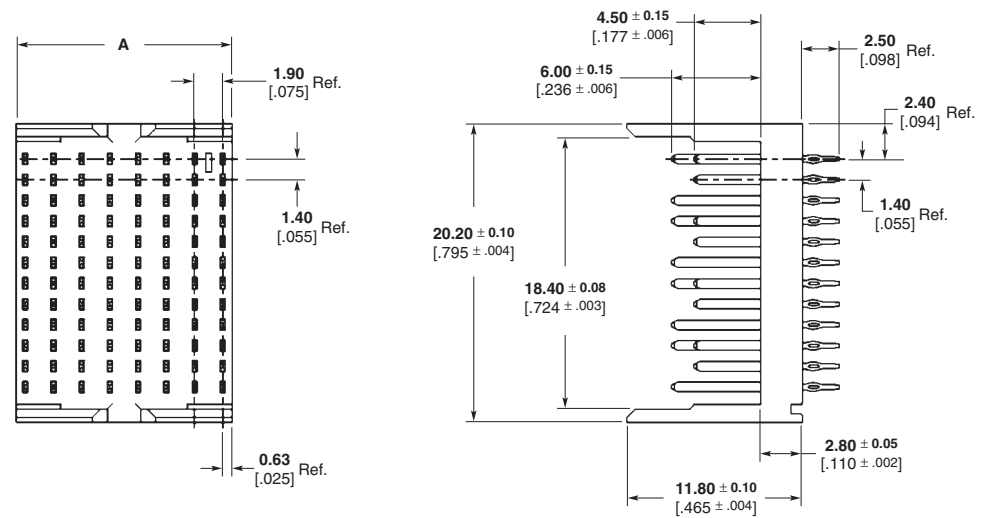
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Backplane
Component Side Shown**

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 Tin-Lead Thickness = **0.008 ± 0.004** [.0003 ± .0002]
 Finishes other than Tin-Lead, See Appl. Spec. 114-13144

4 Pair Vertical Header Assemblies

Column	Part Number	Dimension		Application Tooling*	Mates With
		A	B		
8	1469716-1	14.55 .573	13.30 .524	1804790-1	1469717-1
16	1469687-1	29.75 1.171	28.50 1.122	1804790-3	1469693-1

* Reference Application Specification 114-13144.



Note: For additional information on pcb routing guidelines, reference the Z-PACK MAX Connector Routing Guide Report #25GC004-1.

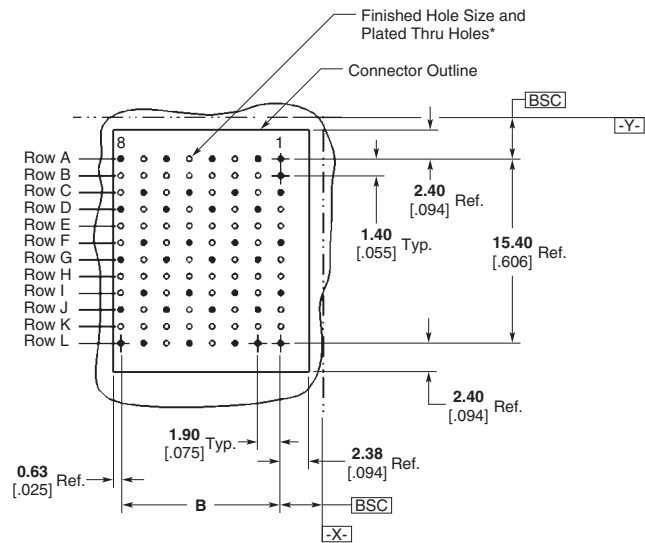
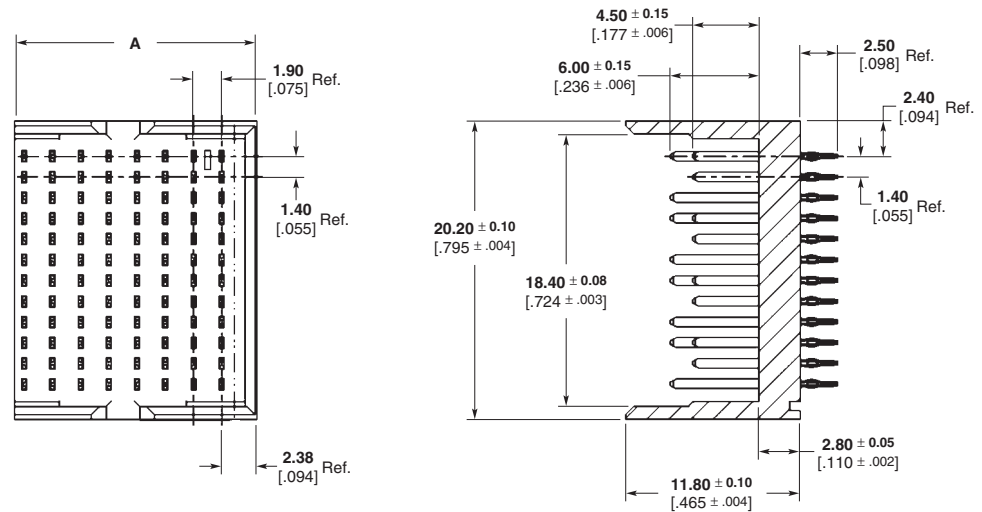
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Backplane
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 Finishes other than Tin-Lead, See Appl. Spec. 114-13144

4 Pair Vertical Header Assemblies — Single End Wall

Column	Part Number	Dimension		Application Tooling*	Mates With
		A	B		
8	1469702-1	16.30 .642	13.30 .524	1804790-1	1469717-1
16	1469703-1	31.50 1.240	28.50 1.122	1804790-3	1469693-1

* Reference Application Specification 114-13144.



Note: For additional information on pcb routing guidelines, reference the Z-PACK MAX Connector Routing Guide Report #25GC004-1.

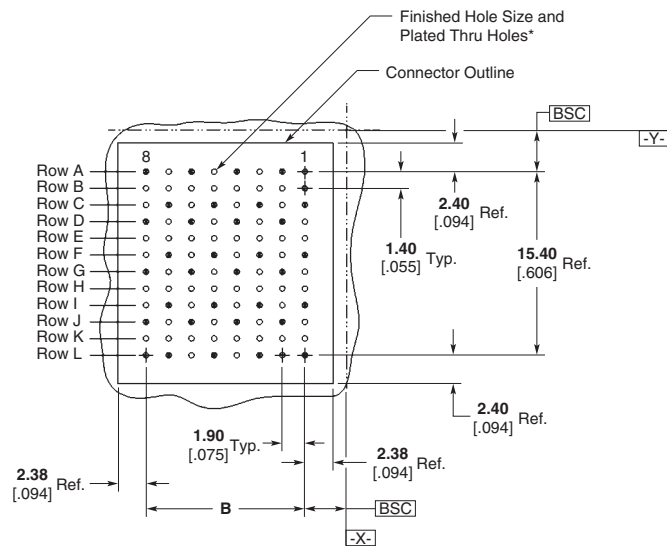
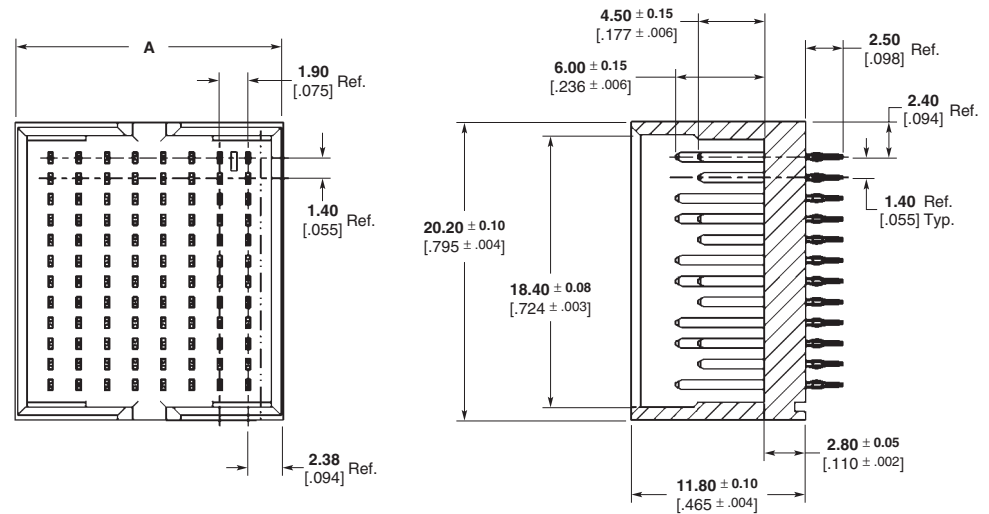
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Backplane
Component Side Shown**

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4 Pair Vertical Header Assemblies — Double End Walls

Column	Part Number	Dimension		Application Tooling*	Mates With
		A	B		
8	1469706-1	18.05 .711	13.30 .524	1804790-1	1469717-1
16	1469707-1	33.25 1.309	28.50 1.122	1804790-3	1469693-1

* Reference Application Specification 114-13144.



Note: For additional information on pcb routing guidelines, reference the Z-PACK MAX Connector Routing Guide Report #25GC004-1.

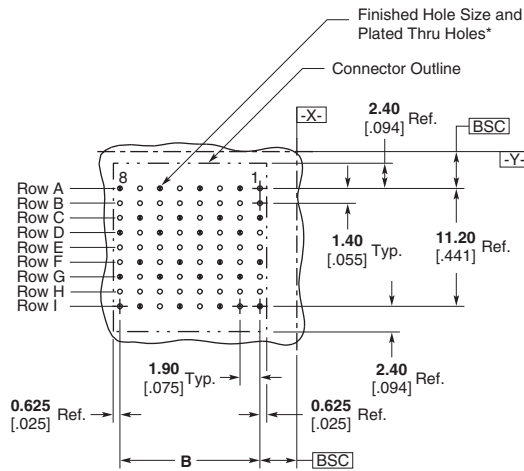
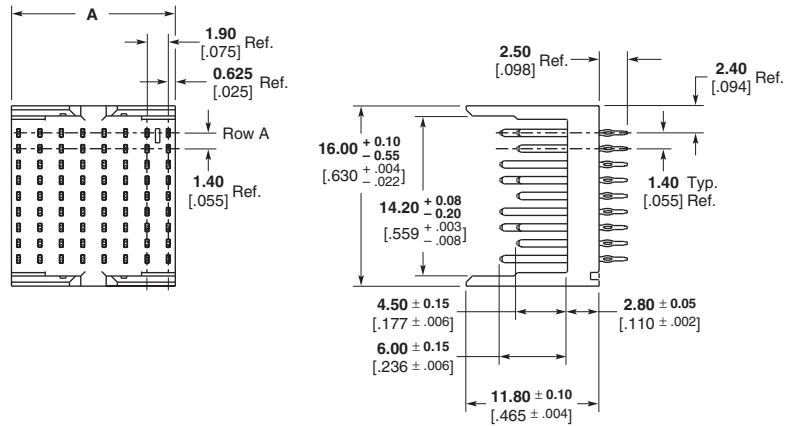
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 Finishes other than Tin-Lead, See Appl. Spec. 114-13144

3 Pair Vertical Header Assemblies

Column	Part Number	Dimension		Application Tooling*	Mates With
		A	B		
8	1469829-1	14.55 .573	13.30 .524	1901457-1	1469831-1
10	1469827-1	18.35 .722	17.10 .673	1901457-2	1469828-1
16	1469949-1	29.75 1.171	28.50 1.122	1901457-3	1469955-1

* Reference Application Specification 114-13144.



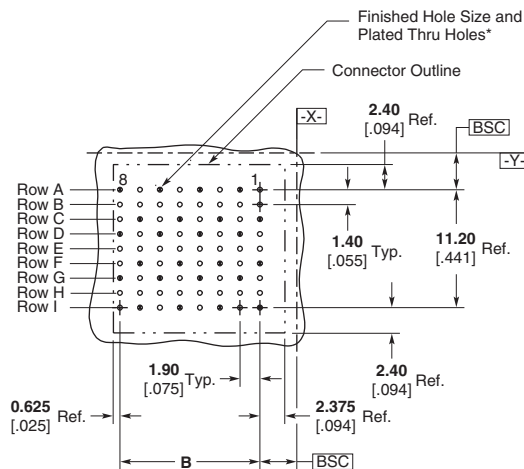
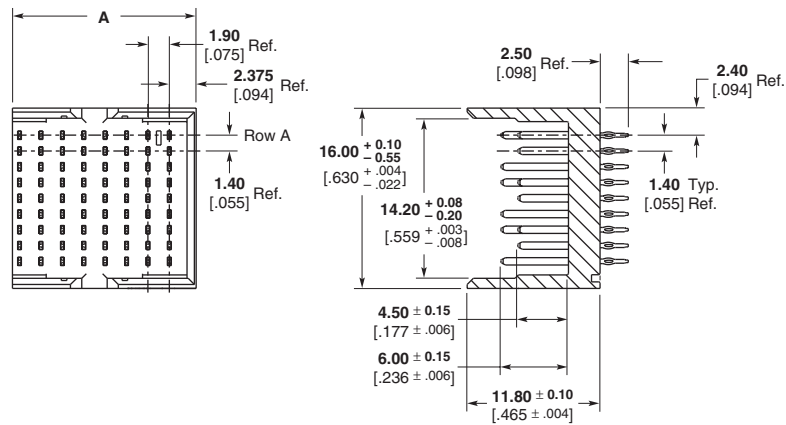
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Component Side Shown**

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 Drilled Hole Diameter = **0.55 ± 0.02** [.022 ± .001]
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 Tin-Lead Thickness = **0.008 ± 0.004** [.0003 ± .0002]
 Finishes other than Tin-Lead, See Appl. Spec. 114-13144

3 Pair Vertical Header Assemblies — Single End Wall

Column	Part Number	Dimension		Application Tooling*	Mates With
		A	B		
8	1469945-1	16.30 .642	13.30 .524	1901457-1	1469831-1
10	1469867-1	20.10 .791	17.10 .673	1901457-2	1469828-1
16	1469950-1	31.50 1.240	28.50 1.122	1901457-3	1469955-1

* Reference Application Specification 114-13144.



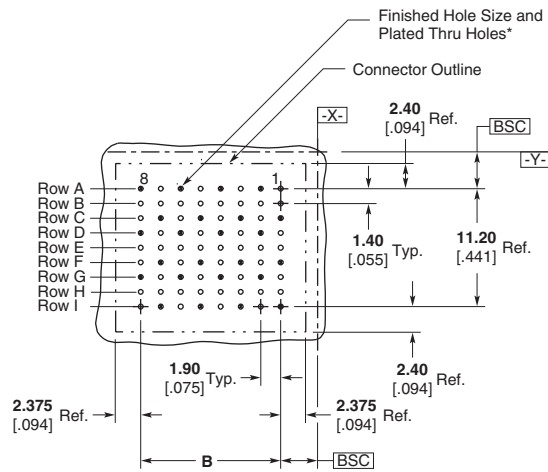
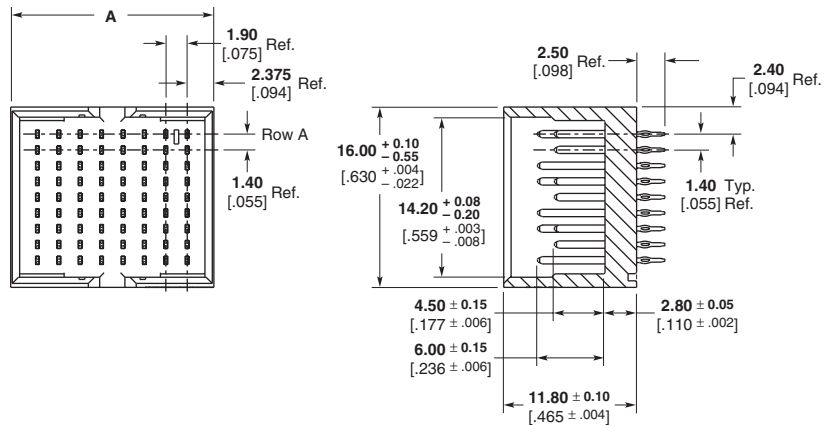
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Component Side Shown**

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 Copper Thickness = 0.038 ± 0.013 [.0015 ± .0005]
 Tin-Lead Thickness = 0.008 ± 0.004 [.0003 ± .0002]
 Finishes other than Tin-Lead, See Appl. Spec. 114-13144

3 Pair Vertical Header Assemblies — Double End Walls

Column	Part Number	Dimension		Application Tooling*	Mates With
		A	B		
8	1469946-1	18.05 .711	13.30 .524	1901457-1	1469831-1
10	1469935-1	21.85 .860	17.10 .673	1901457-2	1469828-1
16	1469951-1	33.25 1.309	28.50 1.122	1901457-3	1469955-1

* Reference Application Specification 114-13144.



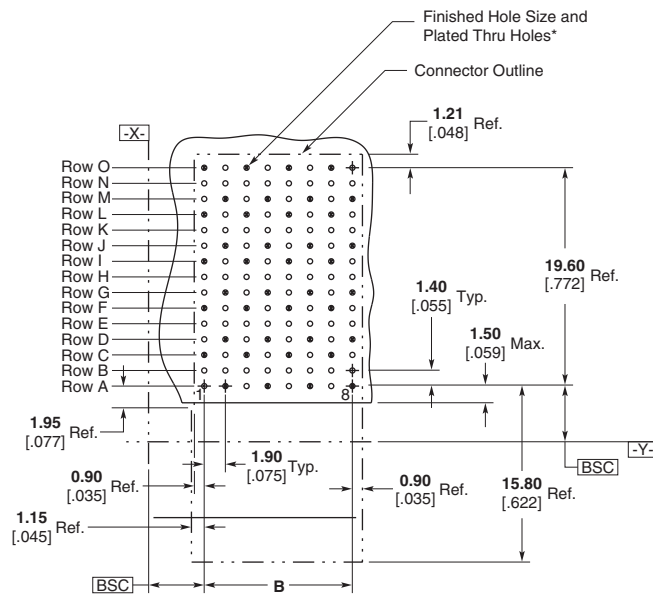
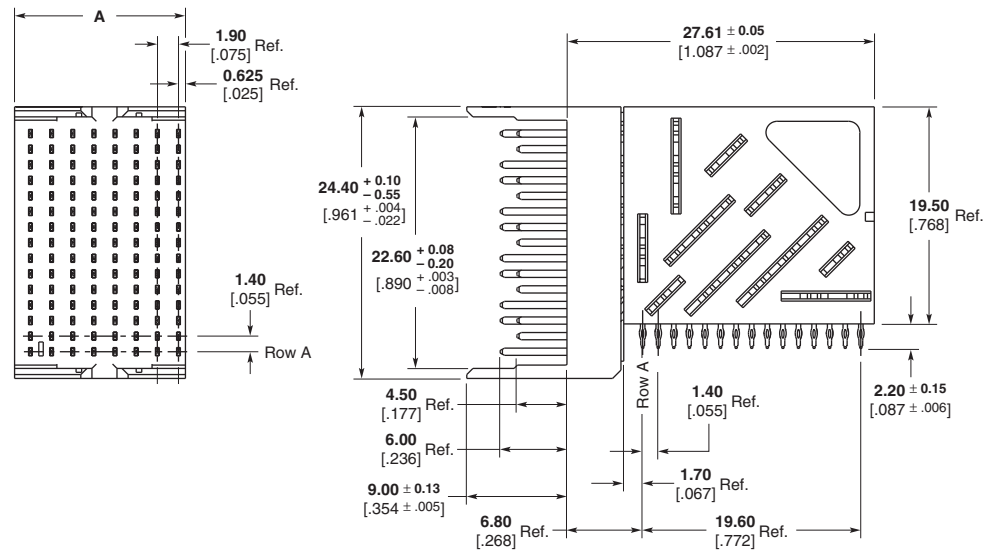
**Recommended PC Board Layout
Component Side Shown**

* Finished Hole Diameter = 0.46 ± 0.05 [.018 ± .002]
 Drilled Hole Diameter = 0.55 ± 0.02 [.022 ± .001]
 Copper Thickness = 0.038 ± 0.013 [.0015 ± .0005]
 Tin-Lead Thickness = 0.008 ± 0.004 [.0003 ± .0002]
 Finishes other than Tin-Lead, See Appl. Spec. 114-13144

5 Pair Right Angle Pin Header Assemblies

Column	Part Number	Dimension		Application Tooling	Mates With
		A	B		
8	1469735-1	15.35 .604	13.30 .524	*	1469659-1
16	1934018-1	30.55 1.203	28.50 1.122	*	1469754-1

* Custom tooling not required. Utilizes flat-rock insertion tooling.
Reference Application Specification 114-13144.



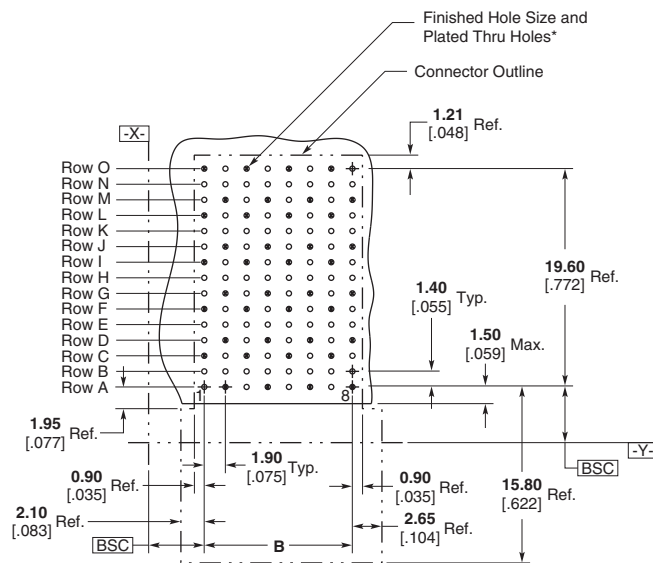
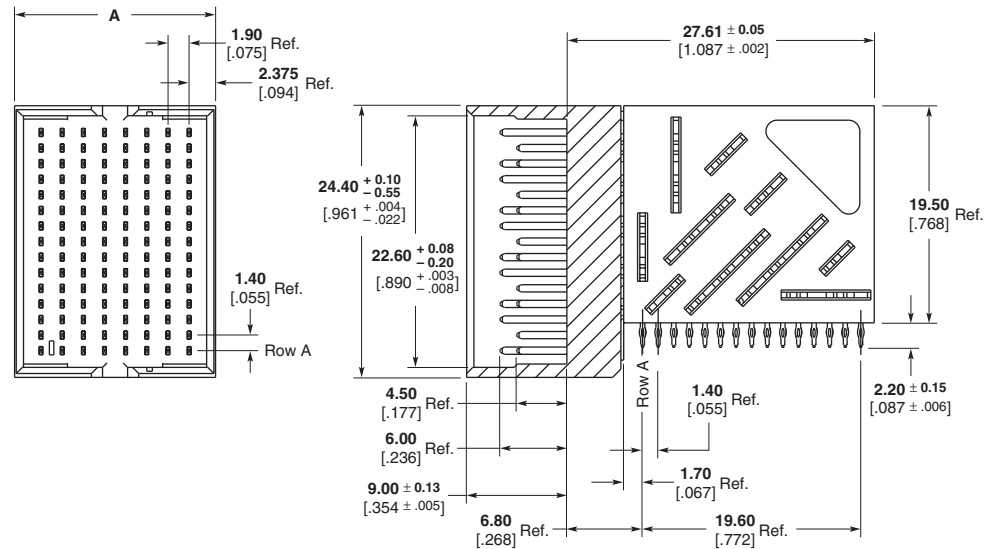
**Recommended PC Board Layout
Component Side Shown**

* Finished Hole Diameter = 0.46 ± 0.05 [0.018 ± .002]
 Drilled Hole Diameter = 0.55 ± 0.02 [0.022 ± .001]
 Copper Thickness = 0.038 ± 0.013 [0.0015 ± .0005]
 Tin-Lead Thickness = 0.008 ± 0.004 [0.0003 ± .0002]
 Finishes other than Tin-Lead, See Appl. Spec. 114-13144

5 Pair Right Angle Pin Header Assemblies — Double End Walls

Column	Part Number	Dimension		Application Tooling	Mates With
		A	B		
8	1469737-1	18.05 .711	13.30 .524	*	1469659-1
16	1934021-1	33.25 1.309	28.50 1.122	*	1469754-1

* Custom tooling not required. Utilizes flat-rock insertion tooling.
Reference Application Specification 114-13144.



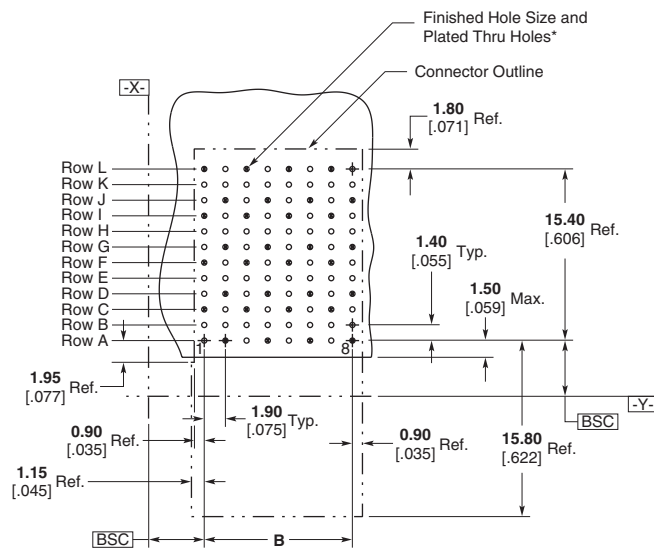
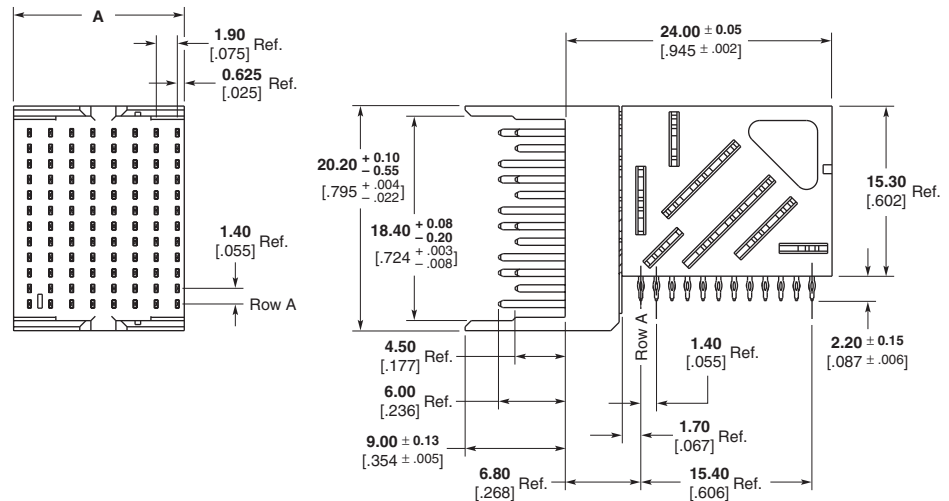
**Recommended PC Board Layout
Component Side Shown**

* Finished Hole Diameter = 0.46 ± 0.05 [.018 ± .002]
 Drilled Hole Diameter = 0.55 ± 0.02 [.022 ± .001]
 Copper Thickness = 0.038 ± 0.013 [.0015 ± .0005]
 Tin-Lead Thickness = 0.008 ± 0.004 [.0003 ± .0002]
 Finishes other than Tin-Lead, See Appl. Spec. 114-13144

4 Pair Right Angle Pin Header Assemblies

Column	Part Number	Dimension		Application Tooling	Mates With
		A	B		
8	1469793-1	15.35 .604	13.30 .524	*	1469717-1
16	1934026-1	30.55 1.203	28.50 1.122	*	1469693-1

* Custom tooling not required. Utilizes flat-rock insertion tooling.
Reference Application Specification 114-13144.



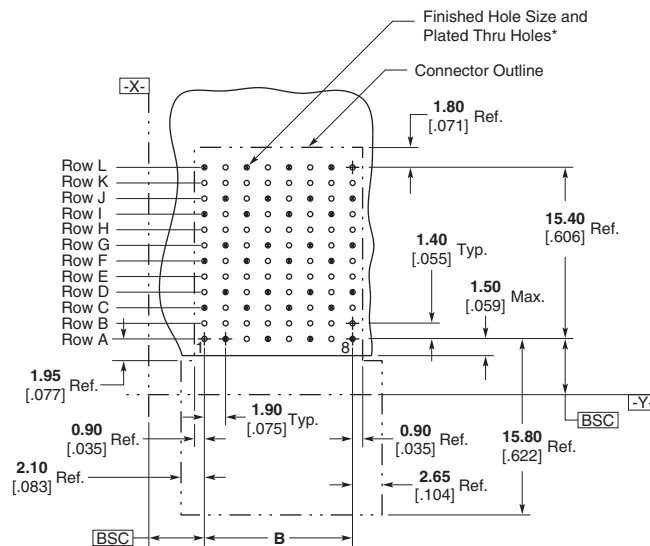
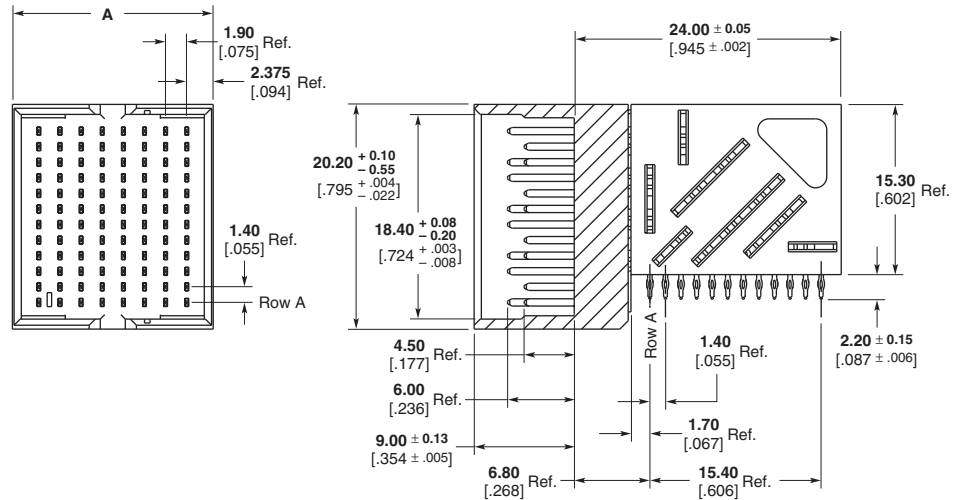
**Recommended PC Board Layout
Component Side Shown**

* Finished Hole Diameter = 0.46 ± 0.05 [0.018 ± .002]
 Drilled Hole Diameter = 0.55 ± 0.02 [0.022 ± .001]
 Copper Thickness = 0.038 ± 0.013 [0.0015 ± .0005]
 Tin-Lead Thickness = 0.008 ± 0.004 [0.0003 ± .0002]
 Finishes other than Tin-Lead, See Appl. Spec. 114-13144

4 Pair Right Angle Pin Header Assemblies — Double End Walls

Column	Part Number	Dimension		Application Tooling	Mates With
		A	B		
8	1469795-1	18.05 .711	13.30 .524	*	1469717-1
16	1934029-1	33.25 1.309	28.50 1.122	*	1469693-1

* Custom tooling not required. Utilizes flat-rock insertion tooling.
Reference Application Specification 114-13144.



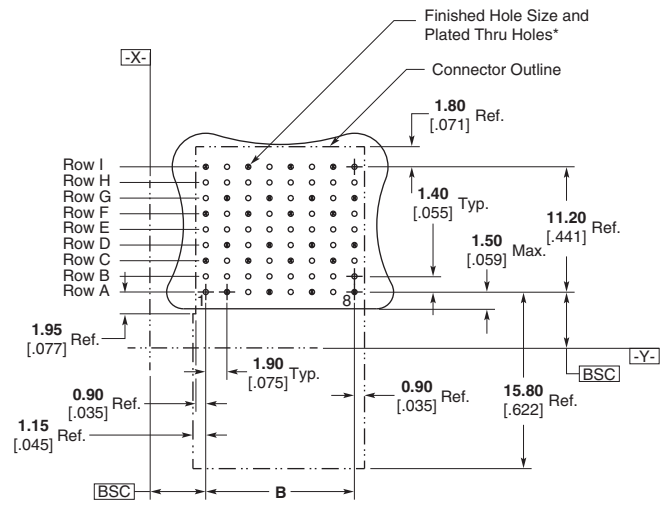
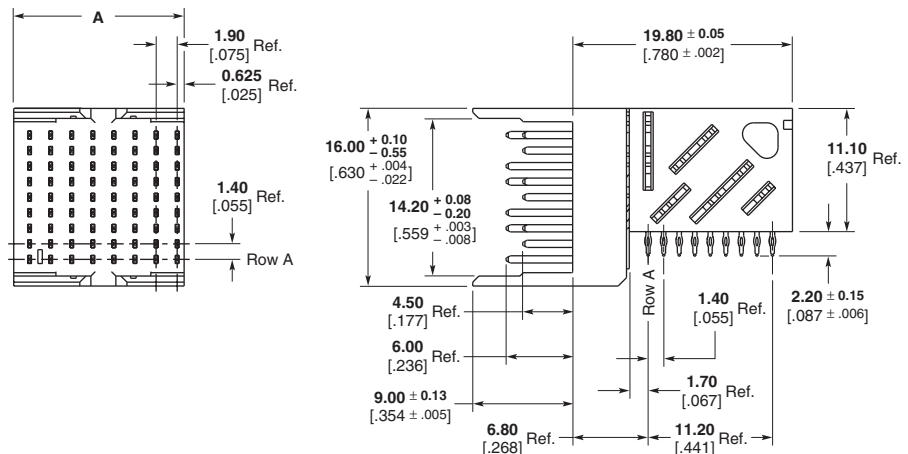
**Recommended PC Board Layout
Component Side Shown**

* Finished Hole Diameter = 0.46 ± 0.05 [0.018 ± 0.002]
 Drilled Hole Diameter = 0.55 ± 0.02 [0.022 ± 0.001]
 Copper Thickness = 0.038 ± 0.013 [0.0015 ± 0.0005]
 Tin-Lead Thickness = 0.008 ± 0.004 [0.0003 ± 0.0002]
 Finishes other than Tin-Lead, See Appl. Spec. 114-13144

3 Pair Right Angle Pin Header Assemblies

Column	Part Number	Dimension		Application Tooling	Mates With
		A	B		
8	1469974-1	15.35 .604	13.30 .524	*	1469831-1
10	1469871-1	19.15 .754	17.10 .673	*	1469828-1
16	1934034-1	30.55 1.203	28.50 1.122	*	1469955-1

* Custom tooling not required. Utilizes flat-rock insertion tooling.
Reference Application Specification 114-13144.



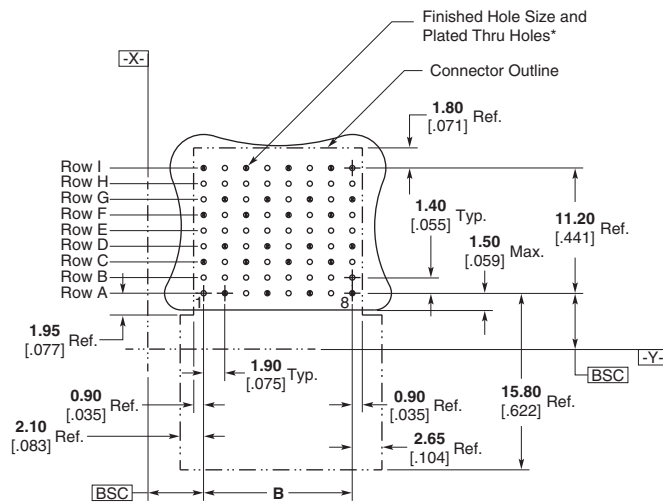
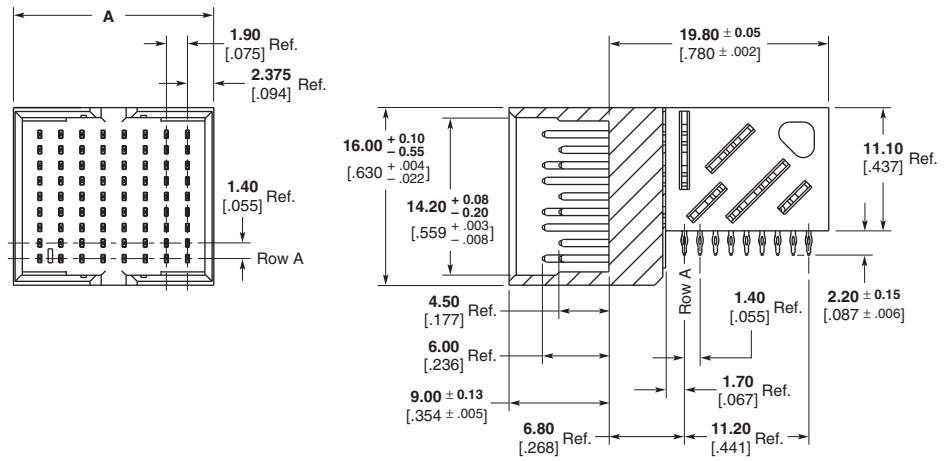
**Recommended PC Board Layout
Component Side Shown**

* Finished Hole Diameter = 0.46 ± 0.05 [018 ± .002]
 Drilled Hole Diameter = 0.55 ± 0.02 [022 ± .001]
 Copper Thickness = 0.038 ± 0.013 [0015 ± .0005]
 Tin-Lead Thickness = 0.008 ± 0.004 [0003 ± .0002]
 Finishes other than Tin-Lead, See Appl. Spec. 114-13144

3 Pair Right Angle Pin Header Assemblies — Double End Walls

Column	Part Number	Dimension		Application Tooling	Mates With
		A	B		
8	1469977-1	18.05 .711	13.30 .524	*	1469831-1
10	1469874-1	21.85 .860	17.10 .673	*	1469828-1
16	1934037-1	33.25 1.309	28.50 1.122	*	1469955-1

* Custom tooling not required. Utilizes flat-rock insertion tooling.
Reference Application Specification 114-13144.



**Recommended PC Board Layout
Component Side Shown**

* Finished Hole Diameter = **0.46 ± 0.05** [0.018 ± .002]
 Drilled Hole Diameter = **0.55 ± 0.02** [0.022 ± .001]
 Copper Thickness = **0.038 ± 0.013** [0.0015 ± .0005]
 Tin-Lead Thickness = **0.008 ± 0.004** [0.0003 ± .0002]
 Finishes other than Tin-Lead, See Appl. Spec. 114-13144

Z-PACK MAX Mid-Plane (Orthogonal) Connector Overview

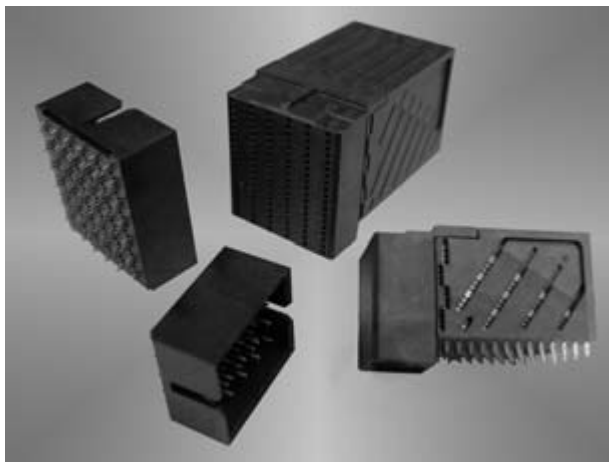
Product Facts

- Scalable to 25 Gbps
- 100 ohm impedance for differential pair configuration
- Very low noise
- Outstanding insertion loss through 2 connectors and vias
- Skewless differential pair in a 2-connector system
- Utilizes the same header and receptacle part on both sides of the mid-plane
- Compatible with standard Z-PACK MAX connectors and accessories
- 4 pair x 4 pair and 6 pair x 6 pair modules available
- Reliable, redundant contact design on all contacts
- Reliable press-fit style termination to PCB
- RoHS compliant

Applications

The Z-PACK MAX Mid-plane (orthogonal) connector is ideally designed for very demanding applications involving data rates in excess of 10 Gbps with many interconnections required. Such applications would include the following Telecom/Datacom equipment:

- Switches
- Servers
- Routers
- Storage



The Z-PACK MAX mid-plane (orthogonal) connector is an extension of the Z-PACK MAX connector product line, which includes perpendicular and coplanar interconnect solutions in 3 pair, 4 pair, and 5 pair versions.

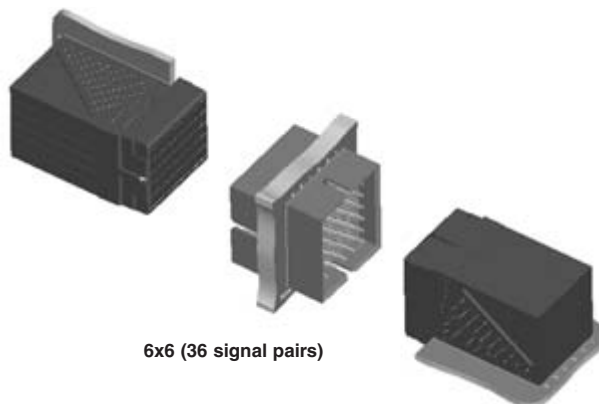
This connector system is commonly referred to as an orthogonal connector system due to the orthogonal (perpendicular) orientation of the two system boards being connected on the front and rear side. It is built on the same technology and design approach as standard Z-PACK MAX connectors with the same mating interface and lead-frame geometry.

Superior electrical performance is achieved for several reasons. The front

board to rear board connection through the mid-plane makes the plated through hole (PTH) part of the signal transmission path eliminating the detrimental effects of via stubs. This construction also eliminates the need to route all the high speed signal lines along the backplane minimizing signal loss and significantly improving signal throughput. The wide column spacing establishes a connector footprint with improved impedance and reduced electrical noise. The in-line footprint version also provides ease of trace routing with wide channels and a connector interface compatible with the orthogonal receptacle. This permits the use of the same daughtercard in both mid-plane and backplane configurations.

The benefits are not limited to just signal integrity performance. The thinner mid-plane with fewer layers and significantly less complex routing is inherently less expensive. With trace routing typically limited to power distribution, low speed lines and potentially very few high speed links, the board can be fabricated from a cost effective material without the need to utilize techniques such as counter-boring or back-drilling.

All of this permits the implementation of small to large scale full mesh interconnects with significantly reduced complexity at a lower cost and with improved signal integrity.



6x6 (36 signal pairs)

For additional information visit:
<http://www.tycoelectronics.com/zpackmax>

Noise Table

- Maximum, multiple source crosstalk

Technical Documents

Product Specification 108-2205

Application Specification
114-13144

Routing Guide Report #26GC015

Material and Finish

Signal Contact — High Strength
Copper Alloy

Ground Contact — High Strength
Copper Alloy

Housing — Liquid Crystal Polymer

Platings — Telcordia compliant interface, Nickel underplate

Compliant Pin Plating —
RoHS Compliant

Ratings

Temperature Range —
-65°C to +90°C

Current Rating — 0.5 A/contact @
< 30°C T-Rise

Durability — 200 cycles

Dielectric Withstanding Voltage —
560 VAC

Operating Voltage — 250 VAC max.

Signal Integrity

Characteristic Impedance —
Differential @ 100 ohms ±10%

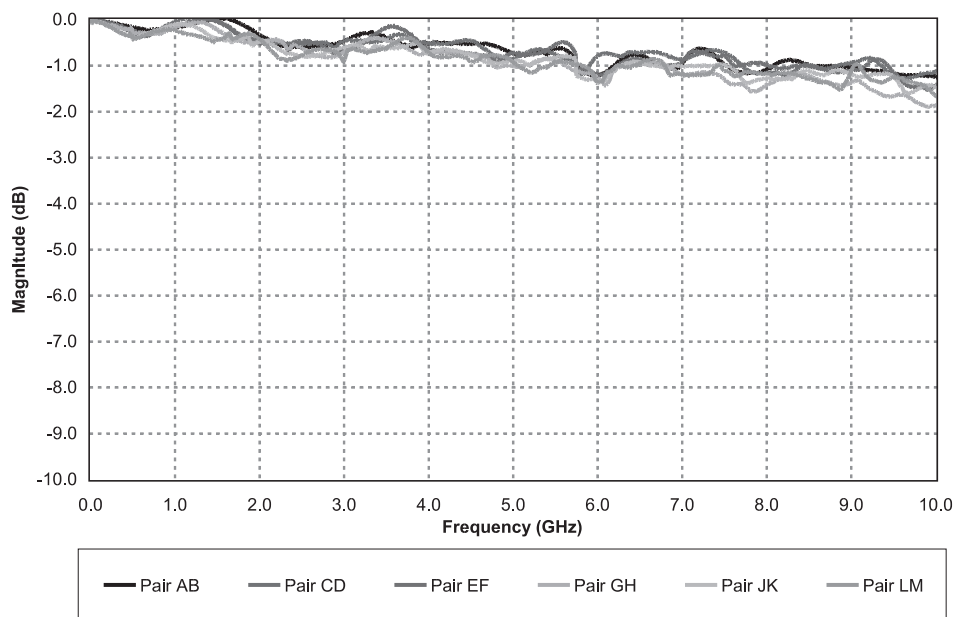
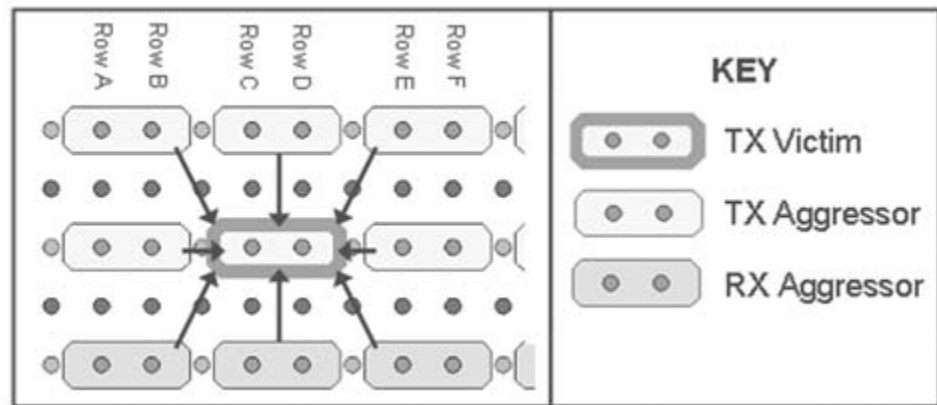
Crosstalk — Multi-pair differential
crosstalk: 1.0% @ 50ps

Insertion Loss — -2 dB @ 10 GHz

Insertion Loss Plot

VICTIM	Total Peak Receiver Noise for Recommended Pin-Out
AB3	0.50%
CD3	1.00%
EF3	0.90%
GH3	0.80%
JK3	0.90%
LM3	0.60%

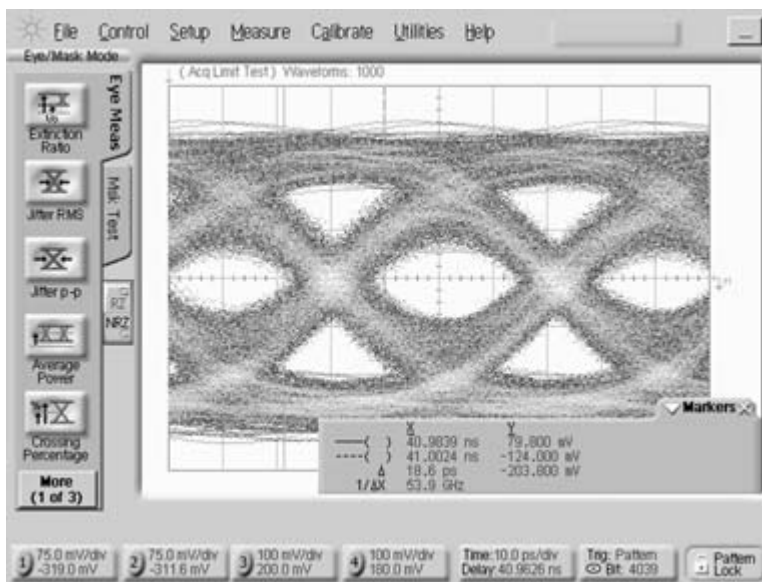
Note: Data includes PCB vias of both backplane and daughtercard connectors.
Single mated connector pair.
50 ps (20-80%) edge rate.



Z-PACK MAX Mid-Plane (Orthogonal) Connector Overview (Continued)

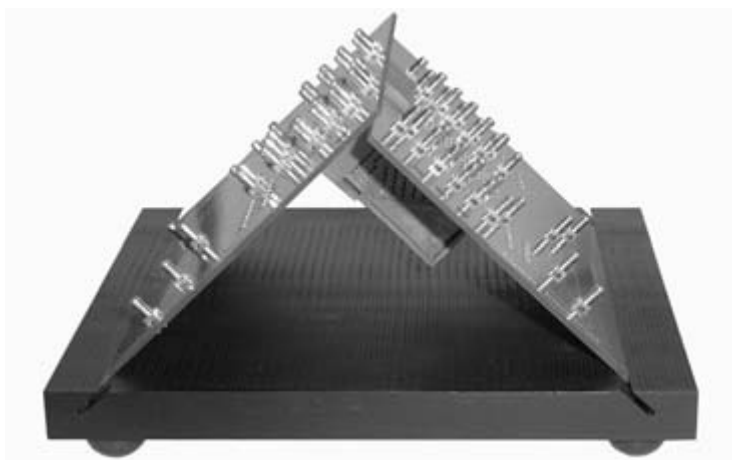
Representative Eye Pattern

- 10.0 Gbps data rate
- 2⁷-1 PRBS
- Unequalized Signal



Customer Connector Evaluation Kit

- Connector characterization
- Available for loan — contact your local Tyco Electronics Sales Engineer
- Time and frequency domain testable
- Testable to 18+ GHz (25+ Gb/s)
- Multiple calibration options
- Convenient SMA interface



Customer System Evaluation Kit

- System characterization
- Available for loan — contact your local Tyco Electronics Sales Engineer
- Time and frequency domain testable
- Testable to 18+ GHz (25+ Gb/s)
- Multiple calibration options
- Convenient SMA interface



6 Pair Mid-Plane Assemblies

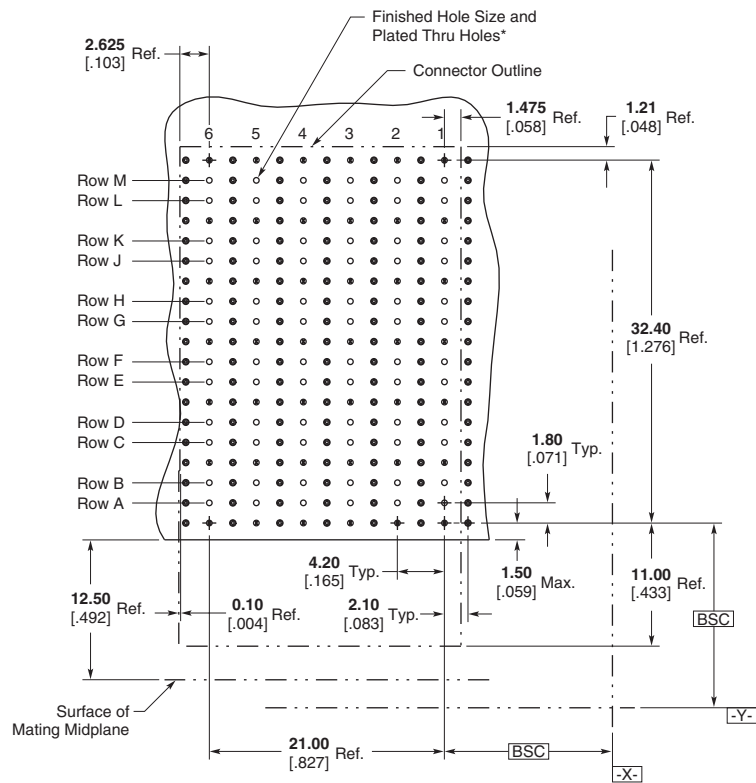
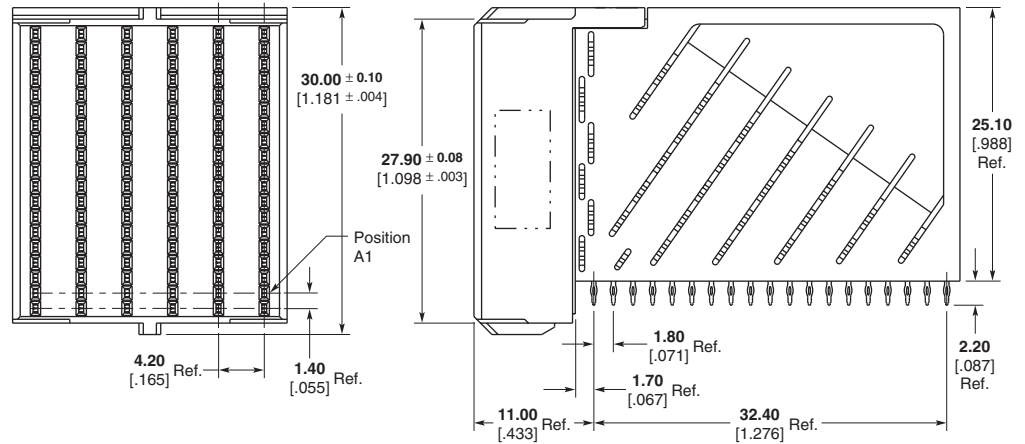
**6 Pair Right Angle
Receptacle Assembly**

Part Number: 1469787-1

Custom tooling not required.
Utilizes flat-rock insertion
tooling.

Reference Application
Specification
114-13144

Mates with: 1469786-1,
1934141-1



**Recommended PC Board Layout
Component Side Shown**

* Finished Hole Diameter = 0.46 ± 0.05 [0.018 ± .002]
 Drilled Hole Diameter = 0.55 ± 0.02 [0.022 ± .001]
 Copper Thickness = 0.038 ± 0.013 [0.0015 ± .0005]
 Tin-Lead Thickness = 0.008 ± 0.004 [0.0003 ± .0002]
 Finishes other than Tin-Lead, See Appl. Spec. 114-13144

6 Pair Mid-Plane Assemblies (Continued)

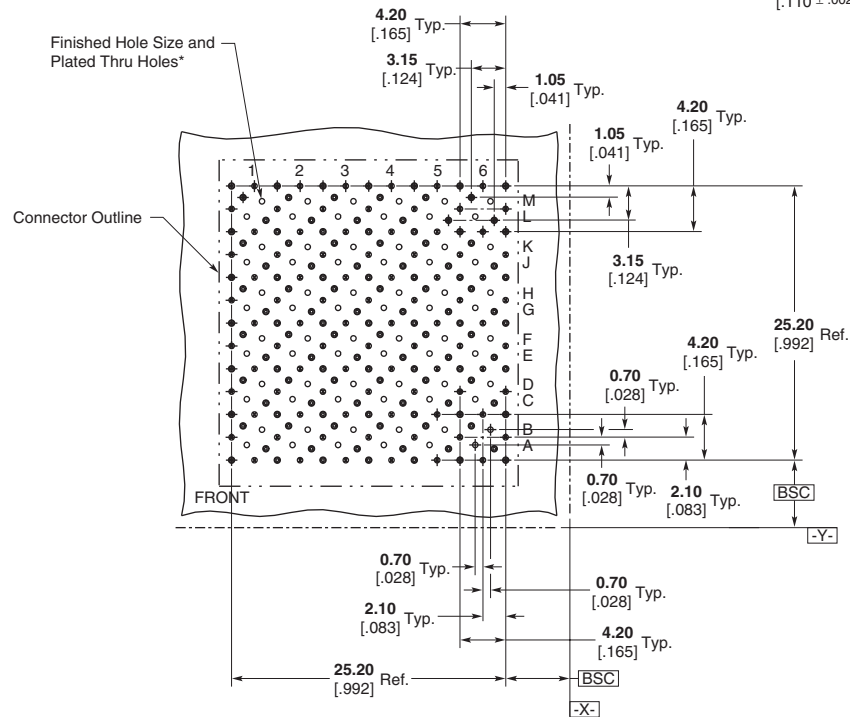
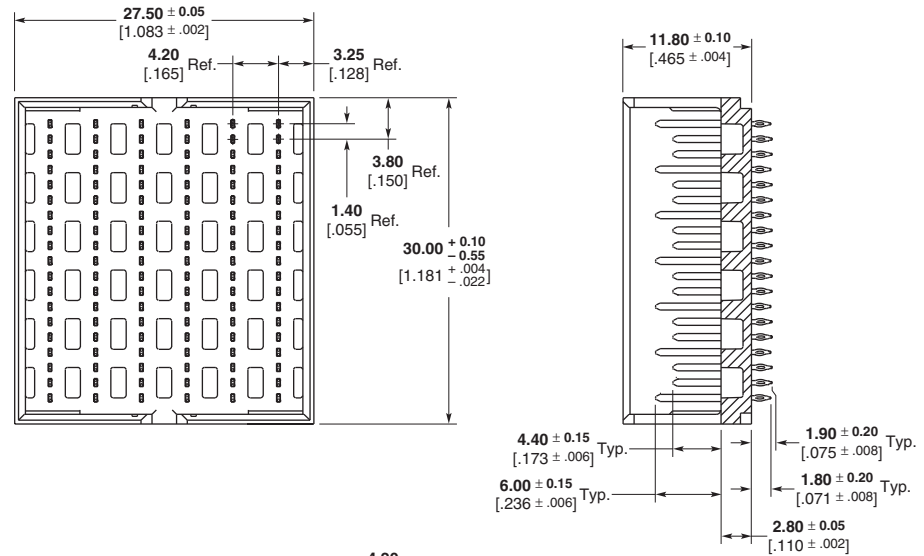
6 Pair Vertical Header Assembly

Part Number: 1469786-1

Insertion Tooling:
1901530-1

Reference Application
Specification 114-13144

Mates with: 1469787-1



**Recommended PC Board Layout
Component Side Shown**

* Finished Hole Diameter = 0.46 ± 0.05 [0.018 ± .002]
 Drilled Hole Diameter = 0.55 ± 0.02 [0.022 ± .001]
 Copper Thickness = 0.038 ± 0.013 [0.0015 ± .0005]
 Tin-Lead Thickness = 0.008 ± 0.004 [0.0003 ± .0002]
 Finishes other than Tin-Lead, See Appl. Spec. 114-13144

6 Pair Mid-Plane Assemblies (Continued)

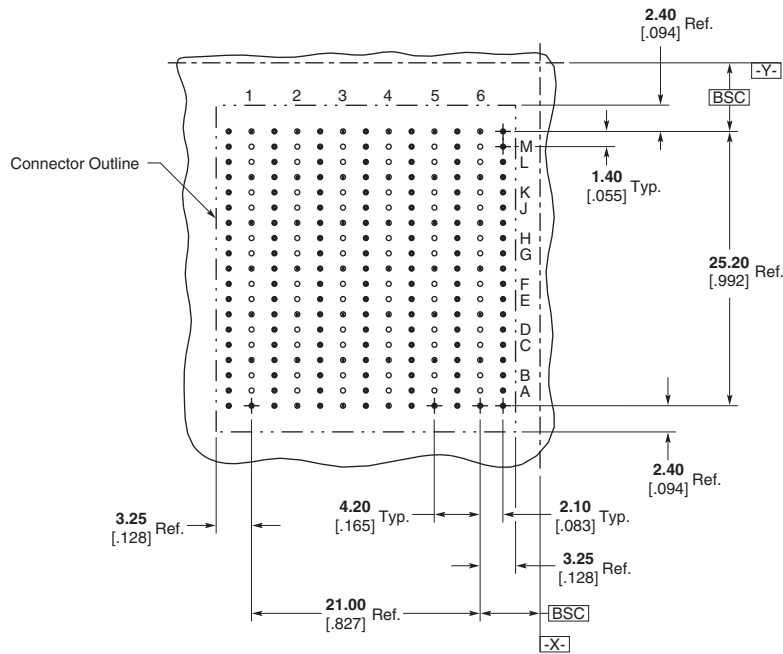
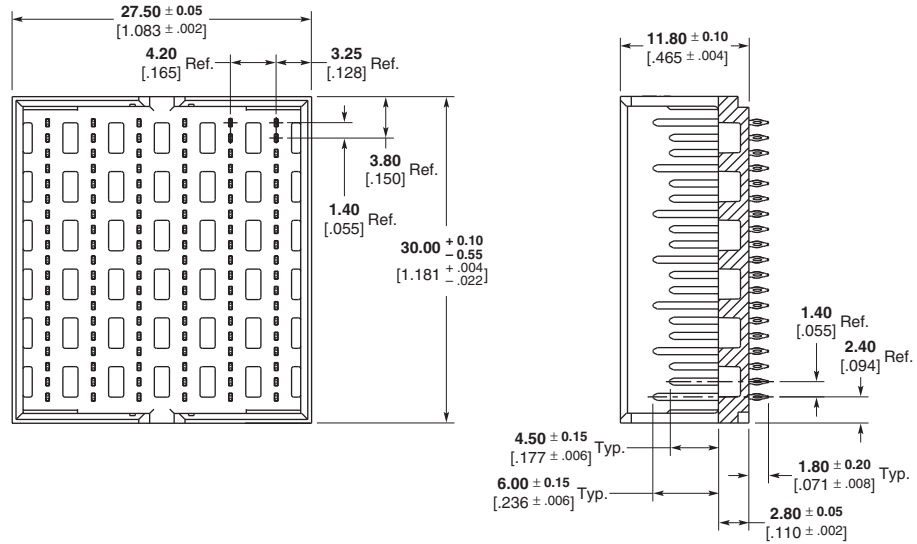
**6 Pair Vertical Header
Assembly — In Line
Footprint**

Part Number: 1934141-1

Insertion Tooling:
1901530-1

Reference Application
Specification 114-13144

Mates with: 1469787-1



**Recommended PC Board Layout
Component Side Shown**

See Appl. Spec. 114-13144 for Recommended
Plated Thru Hole Diameter and Plating Thicknesses

4 Pair Mid-Plane Assemblies

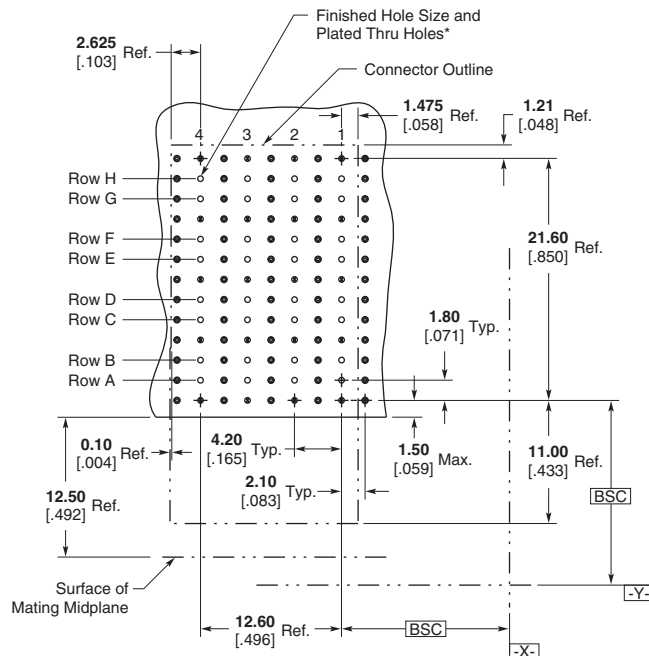
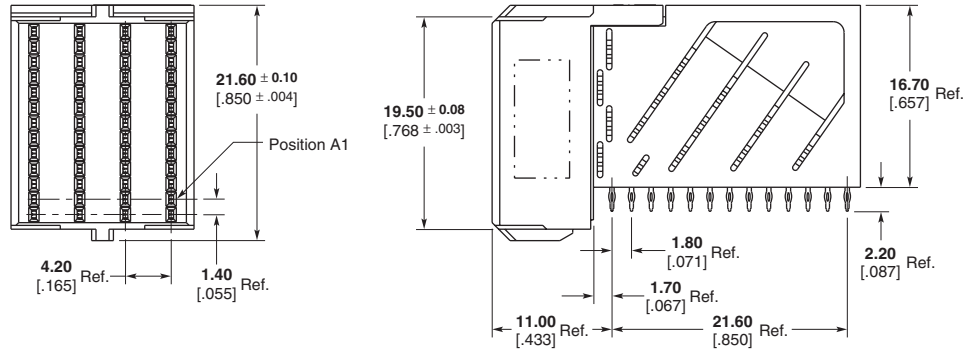
4 Pair Right Angle Receptacle Assembly

Part Number: 1469785-1

Custom tooling not required.
Utilizes flat-rock insertion tooling.

Reference Application Specification 114-13144

Mates with: 1469784-1,
1934165-1



**Recommended PC Board Layout
Component Side Shown**

* Finished Hole Diameter = 0.46 ± 0.05 [0.018 ± .002]
 Drilled Hole Diameter = 0.55 ± 0.02 [0.022 ± .001]
 Copper Thickness = 0.038 ± 0.013 [0.0015 ± .0005]
 Tin-Lead Thickness = 0.008 ± 0.004 [0.0003 ± .0002]
 Finishes other than Tin-Lead, See Appl. Spec. 114-13144

4 Pair Mid-Plane Assemblies (Continued)

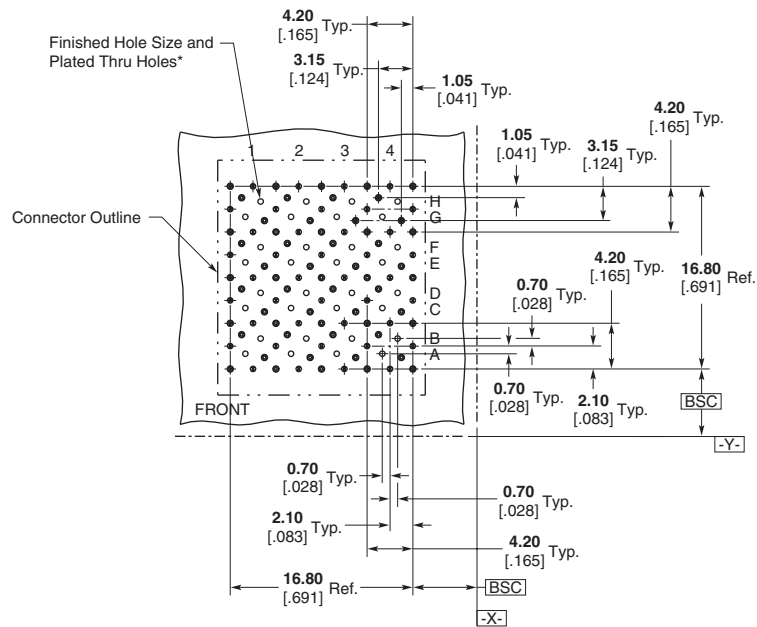
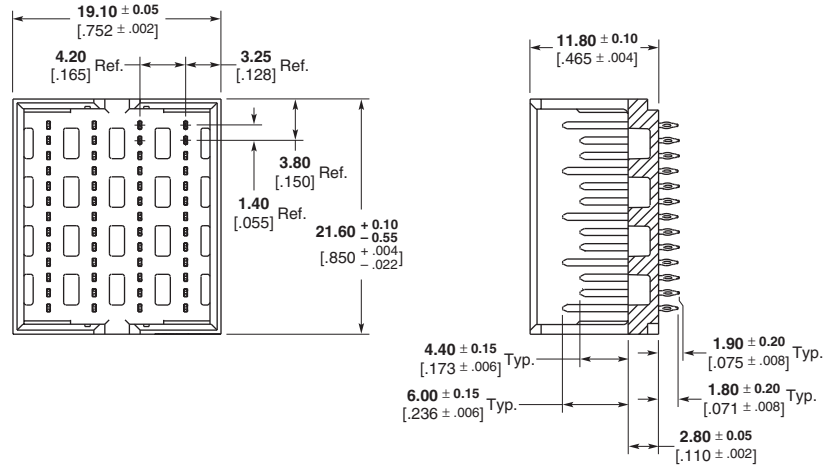
4 Pair Vertical Header Assembly

Part Number: 1469784-1

Insertion Tooling: 1901540-1

Reference Application
Specification 114-13144

Mates with: 1469785-1



**Recommended PC Board Layout
Component Side Shown**

* Finished Hole Diameter = 0.46 ± 0.05 [0.018 ± 0.002]
 Drilled Hole Diameter = 0.55 ± 0.02 [0.022 ± 0.001]
 Copper Thickness = 0.038 ± 0.013 [0.0015 ± 0.0005]
 Tin-Lead Thickness = 0.008 ± 0.004 [0.0003 ± 0.0002]
 Finishes other than Tin-Lead, See Appl. Spec. 114-13144

4 Pair Mid-Plane Assemblies (Continued)

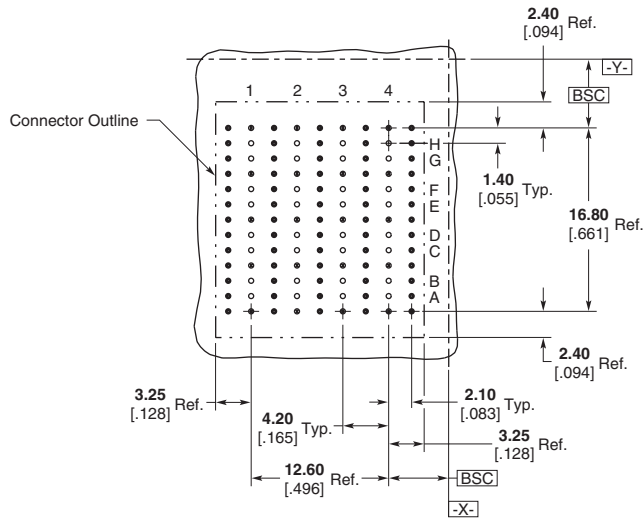
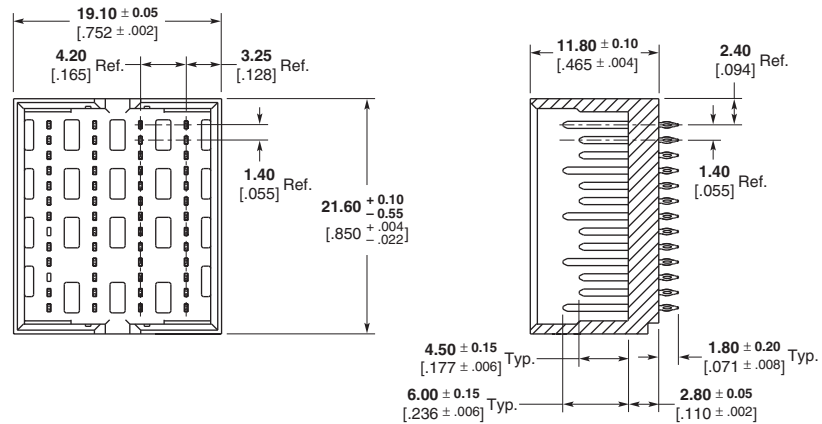
**4 Pair Vertical Header
Assembly — In Line
Footprint**

Part Number: 1934165-1

Insertion Tooling: 1901540-1

Reference Application
Specification 114-13144

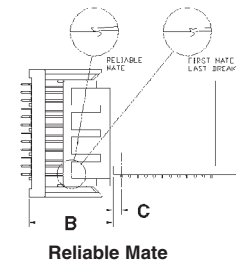
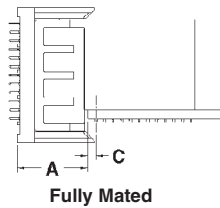
Mates with: 1469785-1



**Recommended PC Board Layout
Component Side Shown**

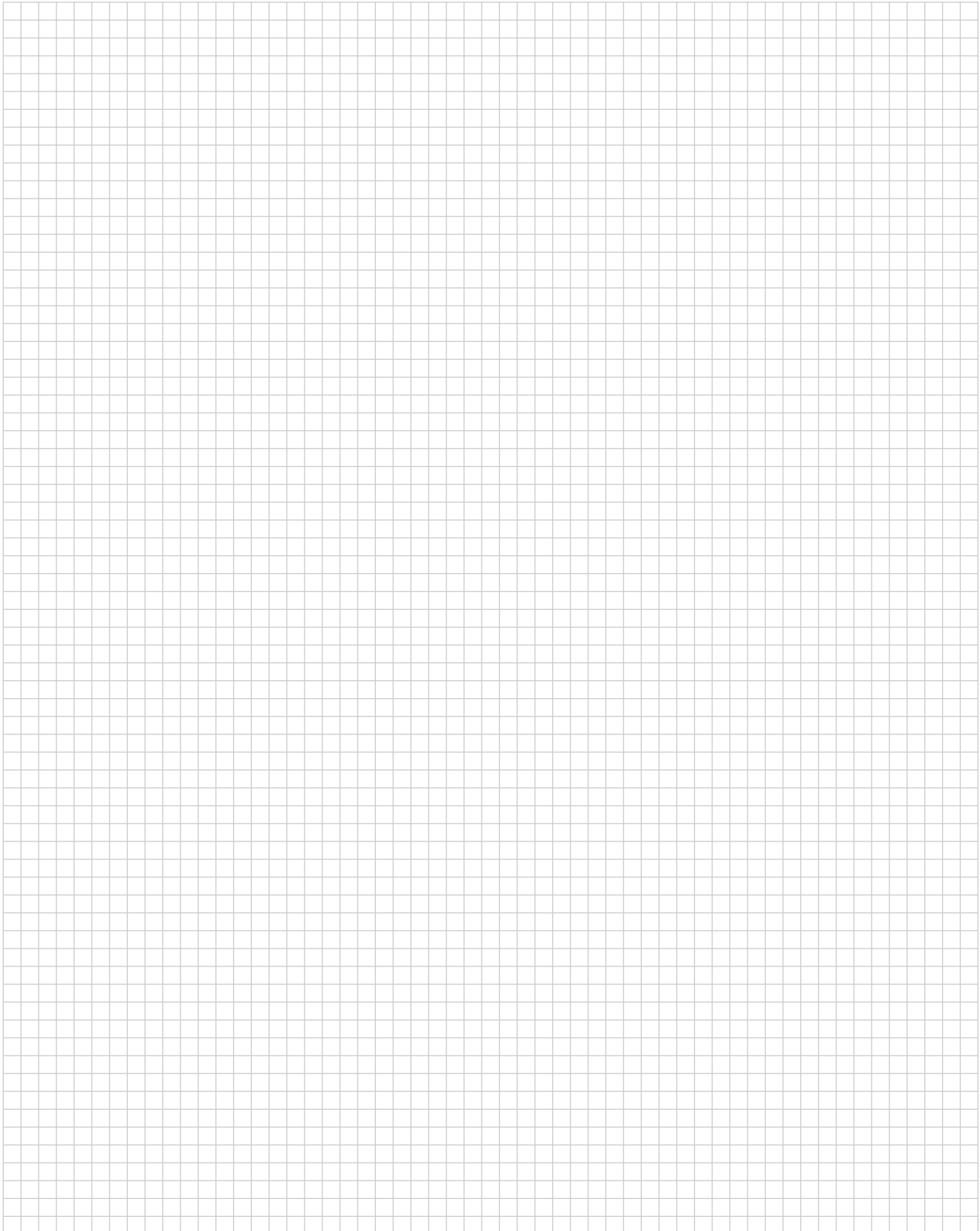
See Appl. Spec. 114-13144 for Recommended
Plated Thru Hole Diameter and Plating Thicknesses

Z-PACK MAX Product Mating Sequence Chart



Product Family	Dim. C	Dim. A Fully Mated	Contact	Dim. B.		Fully Mated Wipe Length
				Reliable Mate	First Mate Last Break	
HM-Zd	1.50 .059	12.50 .492	Ground Shield	16.78 [.661]	17.55 [.691]	4.28 [.169]
			Signal Level 2	15.41 [.607]	15.85 [.624]	2.91 [.115]
HM-Zd Guide Hardware	3.00 .118	12.50 .492	Signal Level 1	13.91 [.548]	14.35 [.565]	1.41 [.056]
			24.0 mm Pin	27.50 [1.083]	33.40 [1.315]	N/A
			22.2 mm Pin	25.70 [1.012]	31.60 [1.244]	N/A
Z-PACK MAX	1.50 .059	12.50 .492	Key Blocking Point	N/A	22.03 [.867]	N/A
			Ground Pins	16.44 [.647]	17.13 [.674]	3.94 [.155]
			Signal Level 2	14.94 [.588]	15.63 [.615]	2.44 [.096]
			Signal Level 1	N/A	N/A	N/A
HM-2mm	1.50 .059	12.50 .492	Signal Level 3	18.27 [.719]	18.84 [.742]	5.77 [.227]
			Signal Level 2	16.77 [.660]	17.34 [.683]	4.27 [.168]
			Signal Level 1	15.27 [.601]	15.84 [.624]	2.77 [.109]
MULTIGIG RT T1	2.50 .098	12.50 .492	Ground	18.00 [.709]	—	5.50 [.217]
			Signal Level 3	18.00 [.709]	—	5.50 [.217]
			Signal Level 2	16.50 [.650]	—	4.00 [.157]
			Signal Level 1	15.00 [.591]	—	2.50 [.098]
MULTIGIG RT T2	2.25 .089	12.50 .492	Ground	18.00 [.709]	—	5.50 [.217]
			Signal Level 3	18.00 [.709]	—	5.50 [.217]
			Signal Level 2	16.50 [.650]	—	4.00 [.157]
			Signal Level 1	15.00 [.591]	—	2.50 [.098]
MULTIGIG RT T3	2.25 .089	12.50 .492	Ground	16.50 [.650]	—	4.00 [.157]
			Signal Level 1	15.00 [.591]	—	2.50 [.098]
			Power Level 3	23.75 [.935]	—	11.25 [.443]
MULTIGIG RT Power Module	5.50 .217	12.50 .492	Power Level 2	22.25 [.876]	—	9.75 [.384]
			Power Level 1	20.75 [.817]	—	8.25 [.325]
			Guide Pin Key	33.25 [1.309]	N/A	20.75 [.817]
MULTIGIG RT Guide Hardware	N/A	12.50 .492	Guide ESD Contact	30.75 [1.211]	—	18.25 [.719]
			Ground	17.08 [.672]	17.60 [.693]	4.78 [.188]
HS-3	1.50 .059	12.50 .492	Signal Level 2	16.05 [.632]	16.47 [.648]	3.75 [.148]
			Signal Level 1	14.55 [.573]	14.97 [.589]	2.25 [.089]
			Power Level 3	20.25 [.797]	20.95 [.825]	8.10 [.319]
UPM	3.50 .138	12.50 .492	Power Level 2	18.65 [.734]	19.35 [.762]	6.50 [.256]
			Power Level 1	17.03 [.670]	17.73 [.698]	4.88 [.192]
			Guide Pin Key	31.39 [1.236]	36.16 [1.424]	N/A
UPM Guide Hardware	5.75 .226	12.50 .492	Keyed Guide Pin	31.39 [1.236]	36.16 [1.424]	N/A
			Keyed Guide Pin	35.23 [1.387]	40.00 [1.575]	N/A
			PreMate Power — Level 1	—	16.84 [.663]	5.61 [.221] Min.
MULTI-BEAM XL Right Angle Header to Vertical Receptacle	5.08 .200	14.73 .580	PostMate Power — Level 2	—	17.81 [.701]	4.34 [.171] Min.
			PreMate Signal — Level 2	—	18.26 [.719]	3.81 [.150] Min.
			PostMate Signal — Level 3	—	19.53 [.769]	2.54 [.100] Min.
			PreMate Power — Level 1	—	15.32 [.603]	5.61 [.221] Min.
MULTI-BEAM XL Right Angle Receptacle to Vertical Header	3.81 .150	13.21 .520	PostMate Power — Level 2	—	16.28 [.641]	4.34 [.171] Min.
			PreMate Signal — Level 2	—	16.74 [.659]	3.81 [.150] Min.
			PostMate Signal — Level 3	—	18.01 [.709]	2.54 [.100] Min.
			PreMate Power — Level 1	—	15.32 [.603]	5.61 [.221] Min.

Engineering Notes



Part Number Index

Note: This index lists all cataloged parts by base no. only. Complete part nos. (with prefixes and/or suffixes) are shown on the page(s) indicated.

Part No.	Page
1469659	6
1469660	9
1469680	10
1469681	11
1469687	12
1469693	7
1469702	13
1469703	13
1469706	14
1469707	14
1469716	12
1469717	7
1469735	18
1469737	19
1469753	9
1469754	6

Part No.	Page
1469755	10
1469756	11
1469784	31
1469785	30
1469786	28
1469787	27
1469793	20
1469795	21
1469827	15
1469828	8
1469829	15
1469831	8
1469867	16
1469871	22
1469874	23
1469935	17

Part No.	Page
1469945	16
1469946	17
1469949	15
1469950	16
1469951	17
1469955	8
1469974	22
1469977	23
1934018	18
1934021	19
1934026	20
1934029	21
1934034	22
1934037	23
1934141	29
1934165	32

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